XC9213 Series

Driver Transistor built-in Synchronous Step-Down DC/DC Controller IC - Input Voltage : 25V

☆GO-Compatible

May 23, 2005 V7

◆Synchronous Bootstrap N-ch & N-ch Driver
◆Input Voltage Range :4.0V ~ 25.0V
◆Oscillation Frequency :300kHz (accuracy±15%)
◆High Efficiency :93% (TYP.)
◆PWM / PFM Manual Switching Control
◆Overcurrent Protection Circuit Built-In
◆TSSOP-16 package

■APPLICATIONS

●PDAs
●Mobile phones
●Note book computers
●Portable audio systems
●Various multi-function power supplies

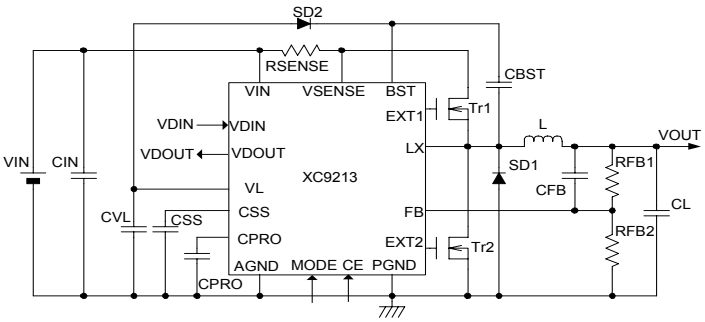
■GENERAL DESCRIPTION

The XC9213 series is N-ch & N-ch drive, synchronous, step-down DC/DC controller IC with a built-in bootstrap driver circuit. Output will be stable no matter which load capacitors, including low ESR capacitors, are used.
Resistance (RSENSE) of about several 10mΩ will be required as a current sense. The phase compensation is also run when a low ESR capacitor is used. In addition, the circuit is double protected by the ways of limiting the current while detecting overshoot current and making output shutdown at any given timing by a protection time setting capacitor (CPRO).
The output voltage can be set freely within a range of 1.5V~15.0V with 1.0V (accuracy±2%) of internal reference voltage by using externally connected resistors (RFB1, 2). Synchronous rectification PWM control can be switched to non-synchronous current limit PFM/PWM automatic switchable control (=voltage between RSENSE pins) by using the MODE pin.
The series has a built-in voltage detector for monitoring a selected voltage by external resistors.
During stand-by (CE pin = low) all circuits are shutdown to reduce current consumption to as low as 4.0μA or less.

■FEATURES

Input Voltage Range	:4.0V ~ 25.0V
Output Voltage Range	:1.5V ~ 15.0V externally set Reference voltage : 1.0V (±2%)
Oscillation Frequency	:300kHz (±15%)
Output Current	:More than 5A (VIN=5.0V, VOUT=3.3V)
Control	:PWM/PFM manual -switching control
Current Limiter, Protection	:Current limit operates at voltage sense 170mV (TYP.). Shutdown time can be adjusted by CPRO.
High Efficiency	:93% [TYP. PWM Mode @ VIN=5.0V, VOUT = 3.3V, IOUT=1A]
Detect Voltage Function	:Detects 0.9V / Open-drain output
Stand-by Current	:ISTB = 4.0μA (MAX.)
Load Capacitor	:Low ESR capacitor compatible
Package	:TSSOP-16

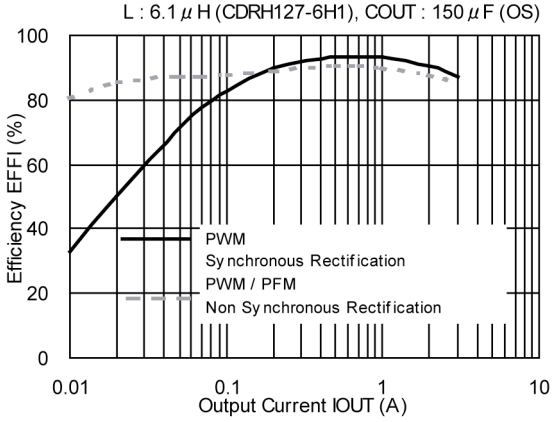
■TYPICAL APPLICATION CIRCUIT



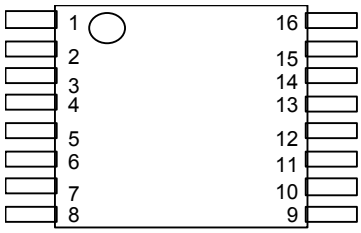
■TYPICAL PERFORMANCE CHARACTERISTICS

XC9213B103V (FOSC:300kHz,3.0V)

VIN : 5.0V, Tr1,Tr2: IRF7313,
L : 6.1μH (CDRH127-6H1), COUT : 150μF (OS)



■PIN CONFIGURATION



TSSOP-16 (TOP VIEW)

■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION	
1	VIN	Input Voltage	
2	VSENSE	Current Detection	
3	VL	Local Power Supply	
4	CE	Chip Enable	
5	AGND	Analog Ground	
6	MODE	PWM / Current Limit PFM Switch	
7	CPRO	Protection Time Setting Capacitor Connection	<Set shutdown time of VOUT when detecting overcurrent>
8	CSS	Soft-start Capacitor Connection	<Set soft-start time>
9	VDIN	Voltage Detector Input (0.9V)	
10	FB	Output Voltage Setting Resistor Connection	< Set output voltage freely by split resistors >
11	VDOUT	Voltage Detector Output (Open-Drain)	
12	PGND	Power Ground	
13	EXT2	Low Side N-ch Driver Transistor	<Connect to Gate of Low Side N-ch MOSFET >
14	LX	Coil Connection	
15	EXT1	High Side N-ch Driver Transistor	<Connect to Gate of High Side N-ch MOSFET >
16	BST	Bootstrap	

■CE PIN & MODE PIN FUNCTION

CE PIN	OPERATIONAL STATE
H	Operation
L	Shut down

MODE PIN	OPERATIONAL STATE
H	Synchronous
	PWM Control
L	Non-Synchronous
	PWM / Current Limit PFM Automatic Switching Control

■PRODUCT CLASSIFICATION

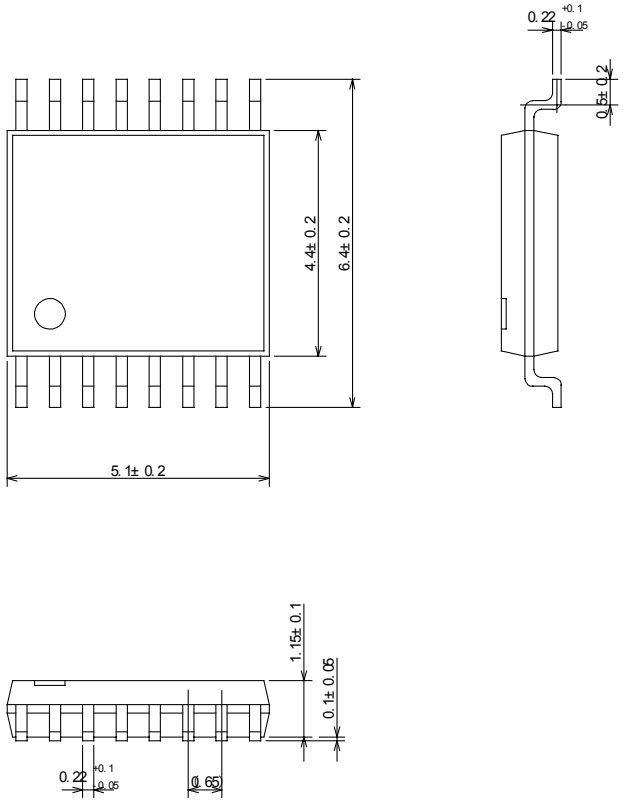
●Ordering Information

XC9213B①②③④⑤

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
① ②	Reference Voltage	10	: 1.0V (Fixed)
③	Oscillation Frequency	3	: 300kHz
④	Package	V	: TSSOP-16
⑤	Device Orientation	R	: Embossed tape, standard feed
		L	: Embossed tape, reverse feed

■PACKAGING INFORMATION

●TSSOP-16



■MARKING RULE

●TSSOP-16

①②③④Represents product series

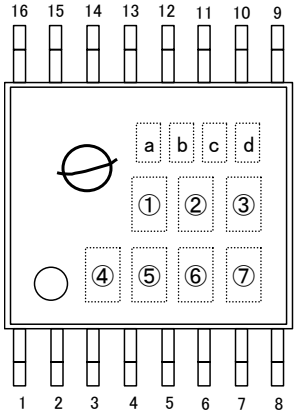
MARK				PRODUCT SERIES
①	②	③	④	
2	1	3	B	XC9213B103Vx

⑤⑥Represents standard voltage

MARK		VOLTAGE (V)	PRODUCT SERIES
⑤	⑥		
1	0	1.0	XC9213B103Vx

⑦Represents oscillation frequency

MARK	OSCILLATION FREQUENCY	PRODUCT SERIES
3	300kHz	XC9213B103Vx



TSSOP-16
(TOP VIEW)

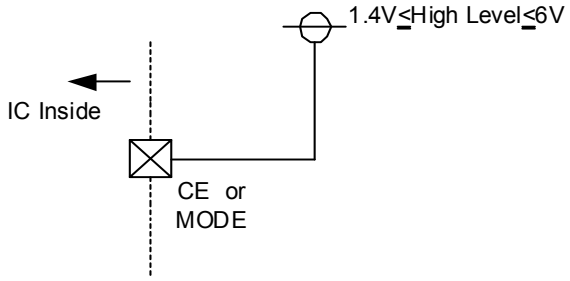
■ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

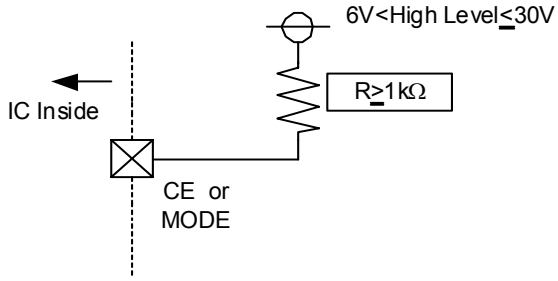
PARAMETER	SYMBOL	RATINGS	UNITS
VIN Pin Voltage	VIN	- 0.3 ~ 30.0	V
VSENSE Pin Voltage	VSENSE	- 0.3 ~ 30.0	V
VL Pin Voltage	VL	- 0.3 ~ 6.0	V
CE Pin Voltage (*)	CE	- 0.3 ~ 30.0	V
MODE Pin Voltage (*)	MODE	- 0.3 ~ 30.0	V
CPRO Pin Voltage	CPRO	- 0.3 ~ 6.0	V
CSS Pin Voltage	CSS	- 0.3 ~ 6.0	V
VDIN Pin Voltage	VDIN	- 0.3 ~ 6.0	V
FB Pin Voltage	FB	- 0.3 ~ 6.0	V
VDOUT Pin Voltage	VDOUT	- 0.3 ~ 30.0	V
EXT2 Pin Voltage	EXT2	- 0.3 ~ 6.0	V
Lx Pin Voltage	Lx	- 0.3 ~ 30.0	V
EXT1 Pin Voltage	EXT1	- 0.3 ~ 30.0	V
BST Pin Voltage	BST	- 0.3 ~ 30.0	V
EXT1 Pin Current	IEXT1	±100	mA
EXT2 Pin Current	IEXT2	±100	mA
Lx Pin Current	ILx	100	mA
Power Dissipation	Pd	350	mW
Operational Temperature Range	Topr	- 40 ~ + 85	°C
Storage Temperature Range	Tstg	- 55 ~ + 125	°C

(*) CE, MODE pin voltage

1) 1.4V≦High Level≦6V
The CE pin and the MODE pin can be connected directly to the high level power supply.



2) 6V < High Level ≦ 30V
The CE pin and the MODE pin should be connected to over 1kΩ resistor when connecting



■ELECTRICAL CHARACTERISTICS

XC9213B103 (FOSC = 300kHz) Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Input Voltage (*2)	VIN		4.0	-	25.0	V	-
Output Voltage Setting Range	VOUTSET		1.5	-	15.0	V	-
FB Control Voltage	VFB		0.980	1.000	1.020	V	1
U.V.L.O. Voltage	UVLO	Voltage which EXT1 pin starts oscillation	1.0	1.5	2.0	V	2
Supply Current 1	IDD1	CE=VIN, FB=0.9V	-	550	800	μA	3
Supply Current 2	IDD2	CE=VIN, FB=1.1V	-	450	600	μA	3
Stand-by Current	ISTB	CE=FB=0V	-	-	4.0	μA	4
Oscillation Frequency	FOSC	CE=VIN, FB=0.9V	255	300	345	kHz	5
Maximum Duty Ratio 1	MAXDTY1	CE=VIN, FB=0.9V	91	95	-	%	5
Maximum Duty Ratio 2	MAXDTY2	CE=VIN, FB=1.1V	-	98	-	%	5
PFM Duty Ratio	PFMDTY	With external components, VOUT=3V, MODE=0V, IOUT=1mA, No RSENSE	2.5	3.0	3.9	μS	6
Sense Voltage	VSENSE	Voltage which EXT1 pin stops oscillation	145	170	200	mV	7
CPRO time	TPRO	CPRO=4700pF, VSENSE=0V→0.5V, Time until VDOUT inverts H to L	2.3	4.7	9.4	ms	8
Soft-Start Time	TSS	With external components, CSS=4700pF, CE=0V→3V, Time until voltage becomes VOUT x 0.95	4	8	21	ms	9
Short Protection Circuit Operating Voltage	VSHORT	VIN-VSENSE:0.3V fixed, FB:SWEEP. Voltage which VDOUT inverts H to L	0.15	0.40	0.72	V	25
Efficiency	EFFI	With external components, IOUT=1A, VOUT=3.0V	-	93	-	%	10
CE "H" Voltage	VCEH	Voltage which EXT1 pin starts oscillation	1.4	-	-	V	11
CE "L" Voltage	VCEL	Voltage which EXT1 pin voltage holding "L" level	-	-	0.4	V	11
MODE "H" Voltage	VMODEH	Voltage which EXT2 pin starts oscillation	1.4	-	-	V	12
MODE "L" Voltage	VMODEL	Voltage which EXT2 pin voltage holding "L" level	-	-	0.4	V	12
EXT1 "H" ON Resistance	REXT1H	FB=0.9V, EXT1=3.6V	-	18	23	Ω	13
EXT1 "L" ON Resistance	REXT1L	FB=1.1V, EXT1=0.4V	-	11	18	Ω	14
EXT2 "H" ON Resistance	REXT2H	FB=1.1V, EXT1=3.6V	-	18	23	Ω	15
EXT2 "L" ON Resistance	REXT2L	FB=0.9V, EXT2=0.4V	-	4	8	Ω	16
Dead Time 1	TDT1	With external components, EXT1:H→L, EXT2:L→H	-	100	-	ns	10
Dead Time 2	TDT2	With external components, EXT2:H→L, EXT1:L→H	-	60	-	ns	10
CE "H" Current	ICEH	CE=5.0V	-	-	0.1	μA	17
CE "L" Current	ICEL	CE=0V	-0.1	-	-	μA	17
MODE "H" Current	IMODEH	MODE=5.0V	-	-	0.1	μA	18
MODE "L" Current	IMODEL	MODE=0V	-0.1	-	-	μA	18
CSS Current	ICSS	CSS=0V	-4.0	-2.0	-	μA	19
FB "H" Current	IFBH	FB=5.0V	-	-	0.1	μA	20
FB "L" Current	IFBL	FB=0V	-0.1	-	-	μA	20

■ELECTRICAL CHARACTERISTICS (Continued)

XC9213B103 (Continued)

●Voltage Regulator (*3)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	VLOUT	FB=1.1V, ILOUT=10mA	3.86	4.00	4.14	V	21
Load Regulation	△ VLOUT	FB=1.1V, 1mA≦ILOUT≦30mA	-	45	90	mV	21
Input Regulation	$\frac{\triangle VLOUT}{\triangle VIN \cdot VLOUT}$	FB=1.1V, ILOUT=10mA, VLOUT+1V≦VIN≦25V	-	0.05	0.1	%/V	21

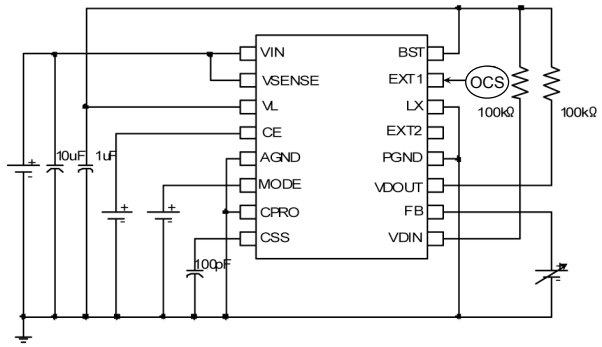
●Voltage Detector

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Detect Voltage	VDF	FB=1.1V, Voltage which VDOUT inverters H to L	0.855	0.900	0.925	V	22
Release Voltage (*4)	VDR	FB=1.1V, Voltage which VDOUT inverters L to H	0.915	0.954	0.980	V	22
Hysteresis Range	HYS	FB=1.1V	2.9	6.0	7.5	%	22
Output Current	VDIOUT	FB=1.1V, VDIN=VDF-0.4V, VDOUT=0.5V	5	15	20	mA	23
Delay Time	TDLY	VDR→VDOUT inversion	-	-	10	μs	22
VDIN Current	IVDIN	VDIN=5.0V	-	-	0.1	μA	24

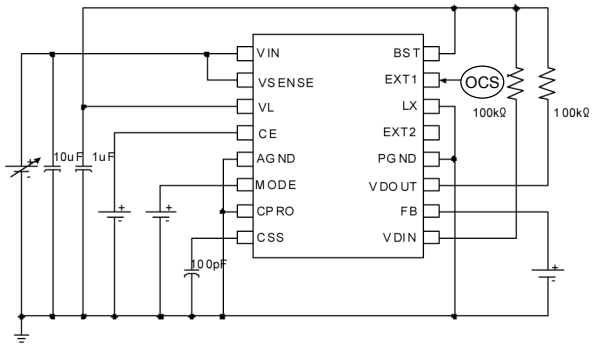
NOTE:
*1: Unless otherwise stated, VIN=5.0V, CE=5.0V, MODE=5.0V, FB=0.9V
*2: The operation may not be stable at no load, if the step-down ratio (VOUT/VIN x 100) becomes lower than 12%.
*3: The regulator block is used only for bootstrap. Please do not use as a local power supply.
*4: Release voltage: (VDR) = VDF + HYS x VDF

■TEST CIRCUITS

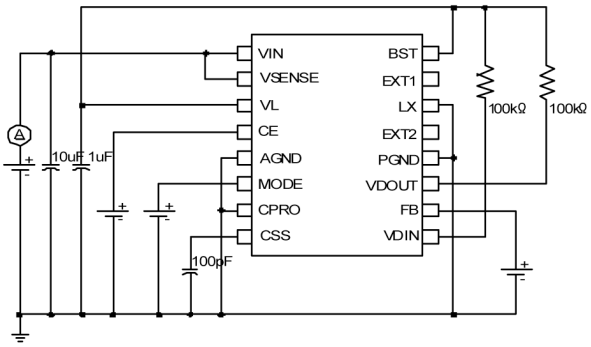
Circuit 1



Circuit 2



Circuit 3



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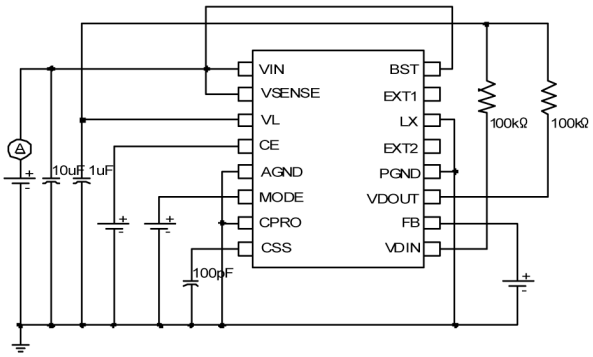

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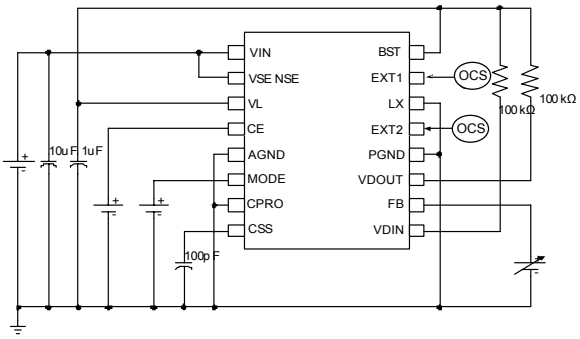

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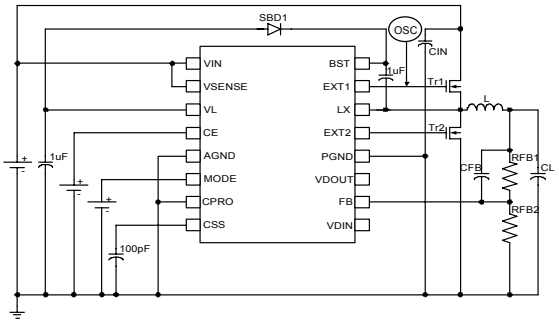
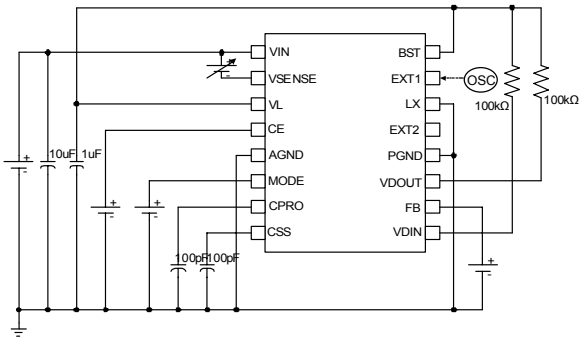


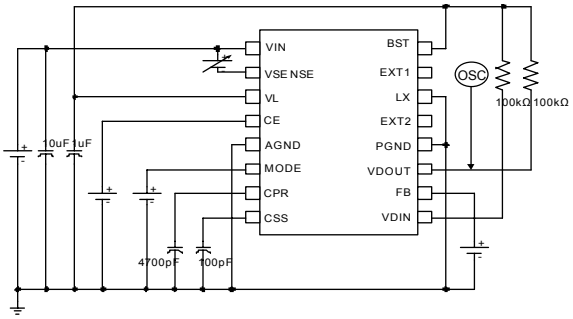
Circuit 7



Tr1:		2SK2857 (NEC)
Tr2:		2SK2857 (NEC)
SBD1:		CRS02 (TOSHIBA)
L:	22μH	CDRH6D28 (SUMIDA)
CL:	100μF	(OS-CON, NIPPON CHEMI-CON)
CIN1:	22μF	(OS-CON, SANYO)
RFB1:	220kΩ	
RFB2:	110kΩ	
CFB:	68pF	

■TEST CIRCUITS (Continued)

Circuit 8



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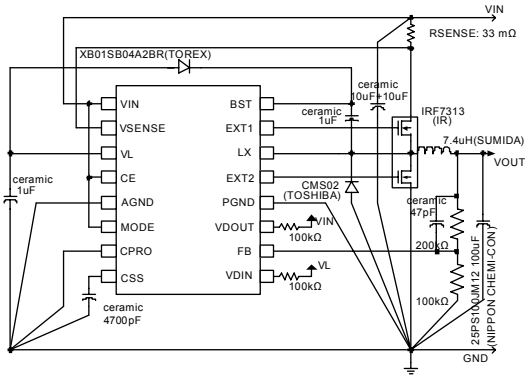

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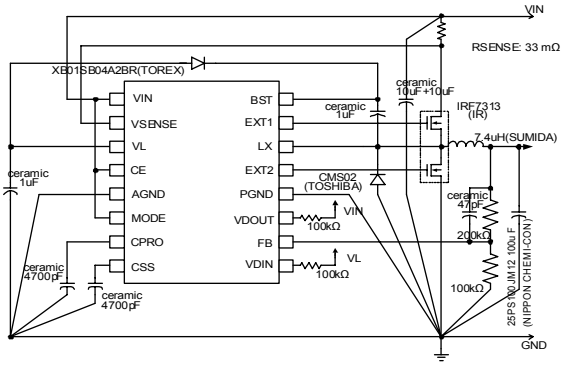

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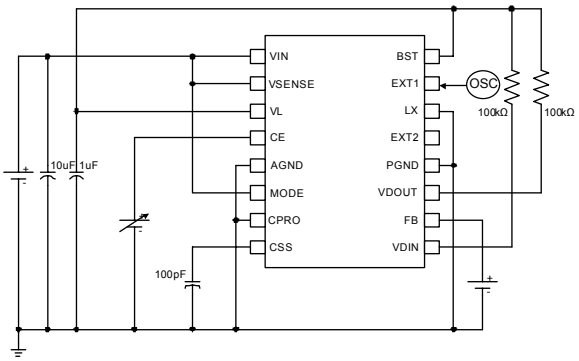

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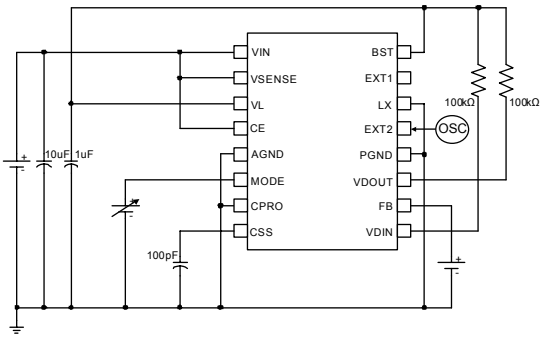

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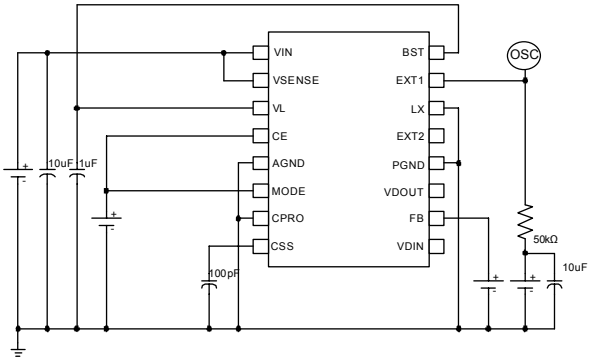
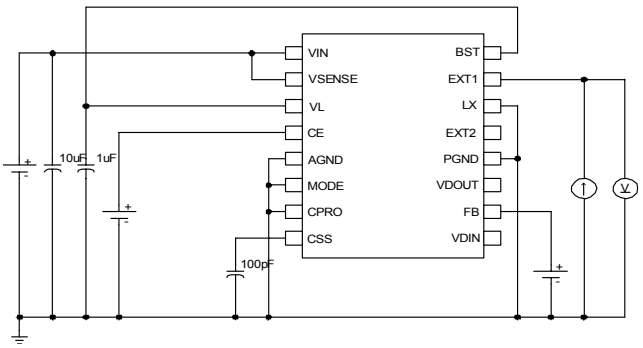
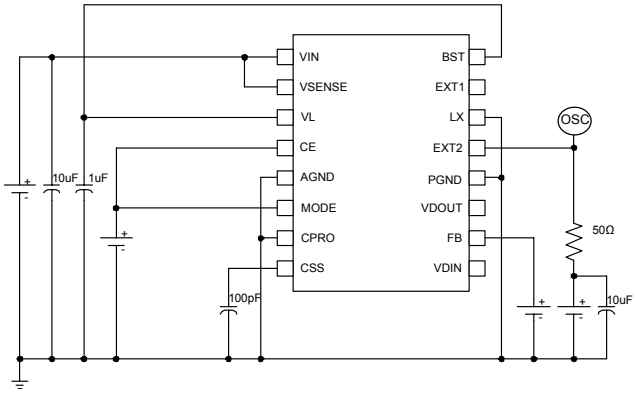


■TEST CIRCUITS (Continued)

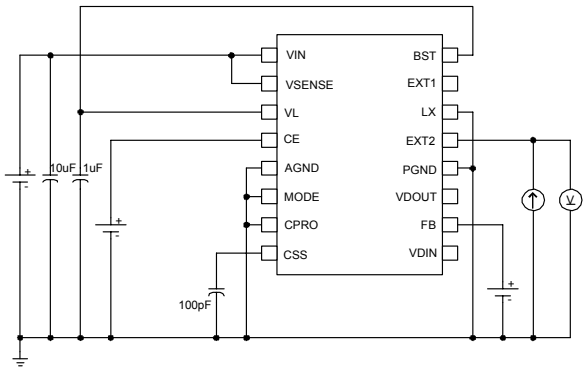
Circuit 14



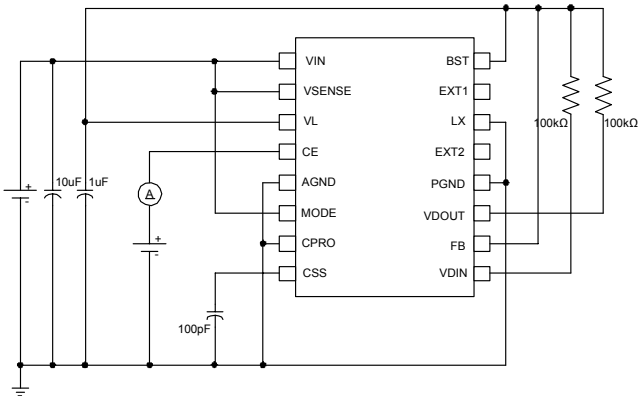
Circuit 15



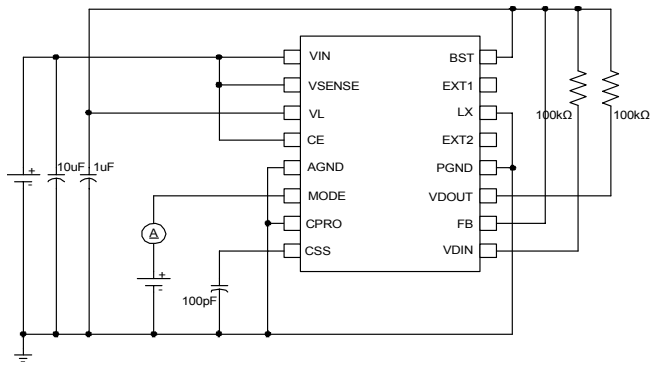
Circuit 16



Circuit 17



Circuit 18



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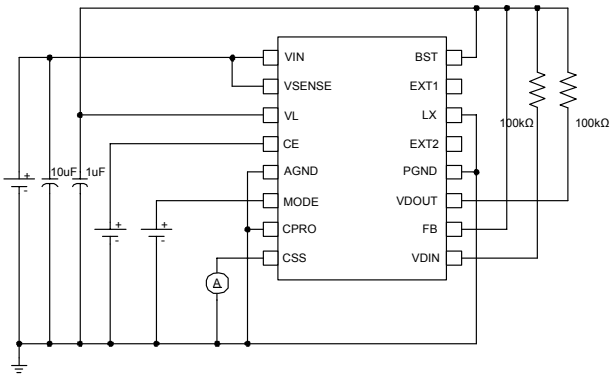
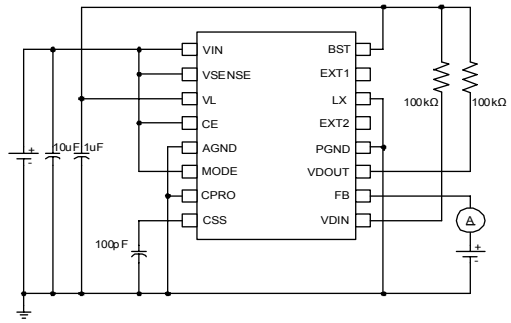
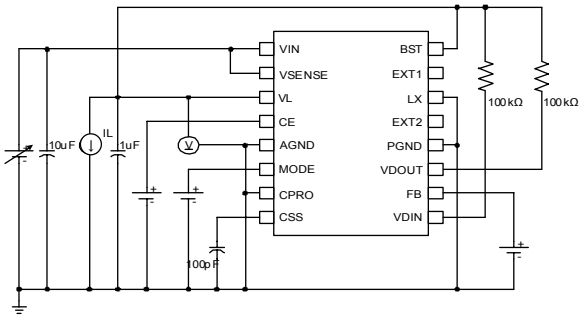


■TEST CIRCUITS (Continued)

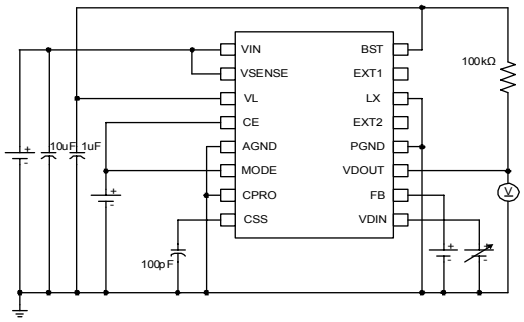
Circuit 20



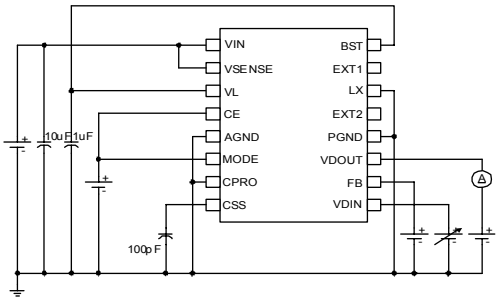
Circuit 21



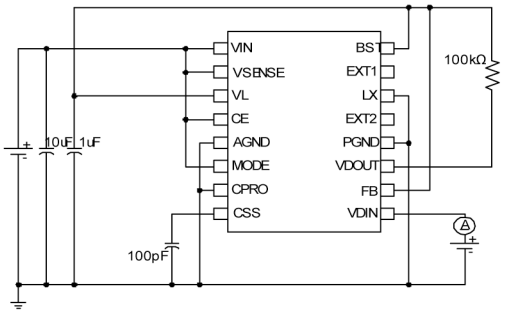
Circuit 22



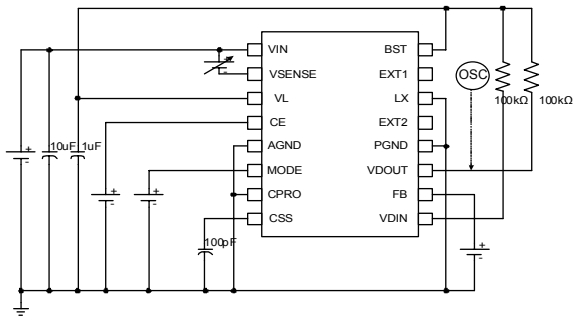
Circuit 23



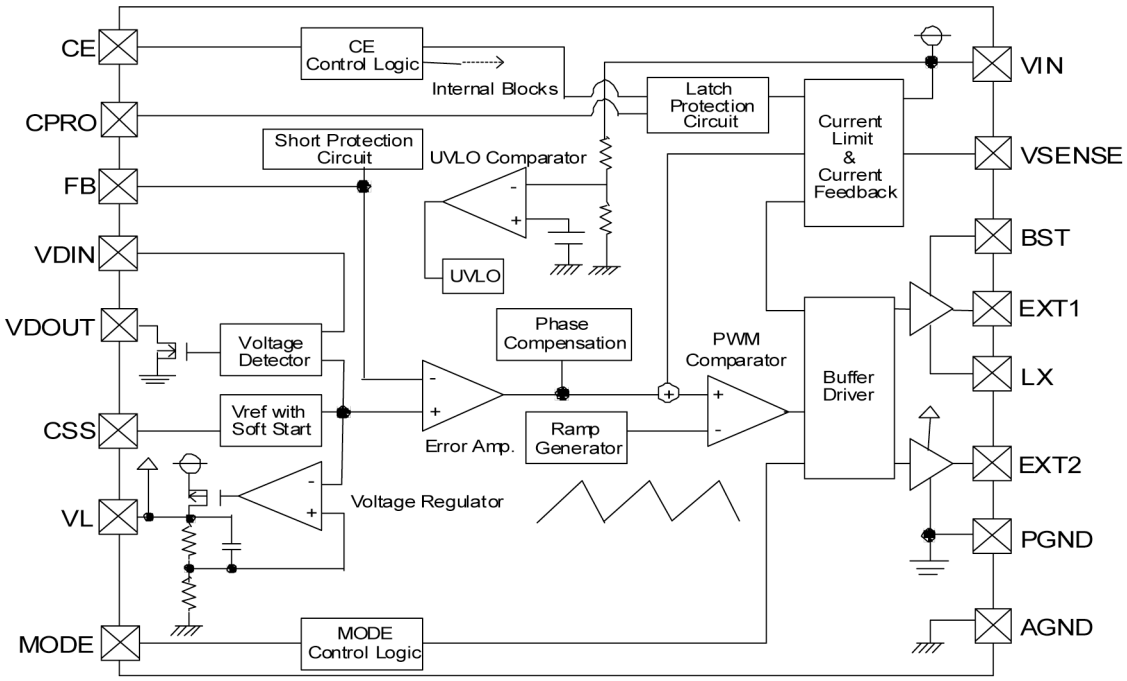
Circuit 24



Circuit 25



■BLOCK DIAGRAM



■OPERATIONAL EXPLANATION

< Error Amplifier >
The error amplifier is designed to monitor output voltage. The amplifier compares the reference voltage with the feedback voltage. When a voltage lower than the reference voltage is fed back, the output voltage of the error amplifier increases.

<Ramp Wave Generator>
The Ramp Wave Generator is organized by the circuits generates a saw-tooth waveform based on the oscillator circuit which sets an oscillation frequency and a signal from the oscillator circuit.

< PWM Comparator >
The PWM Comparator compares outputs from the error amp. and saw-tooth waveform. When the voltage from the error amp's output voltage is low, the external switch will be set to OFF.

< U.V.L.O. Comparator >
When the VIN pin voltage is lower than 1.5V (TYP.), the circuit sets EXT/2 to "L" and the external transistor is forced OFF.

< Voltage Regulator >
The voltage regulator block generates 4.0V voltage for the bootstrap circuit. The regulator block is also the power supply for the internal circuit. Please do not use the regulator block as a local power supply.

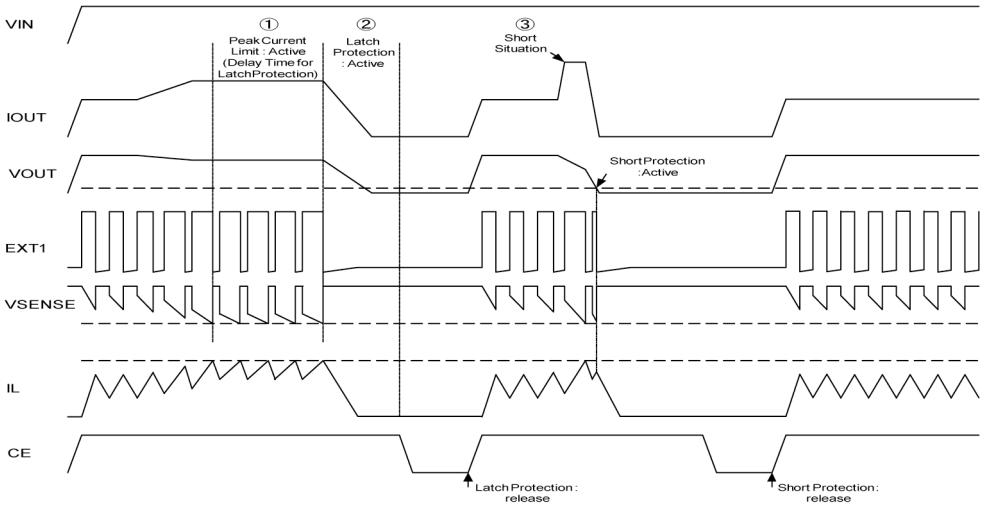
<Vref with Soft Start>
The reference voltage, Vref (FB pin voltage)=1.0V, is adjusted and fixed by laser trimming. The soft-start circuit protects against inrush current, when the power is switched on, and also to protect against voltage overshoot. It should be noted, however, that this circuit does not protect the load capacitor (CL) from inrush current. With the Vref voltage limited and depending upon the input to the error amps, the operation maintains a balance between the two inputs of the error amps and controls the EXT1 pin's ON time so that it doesn't increase more than is necessary.

<CE Control Logic >
This function controls the operation and shutdown of the IC. When the voltage of the CE pin is 0.4V or less, the mode will be chip disable, the channel's operations will stop. The EXT1/2 pins will be kept at a low level (the external N-ch MOSFET will be OFF). When the CE pin is in a state of chip disable, current consumption will be no more than 4.0μA. When the CE pin's voltage is 1.4V or more, the mode will be chip enable and operations will recommence. With soft-start, 95% of the set output voltage will be reached within 8mS (CSS: 4700pF (TYP.)) from the moment of chip enable.

< Voltage Detector >
The voltage detector of the XC9213 series is FB type. The reference voltage is 0.9V (TYP.) and the detect voltage can be set by external resistors. The output is N-ch Open Drain type. The detector is switched on / off with DC/DC by the CE pin.

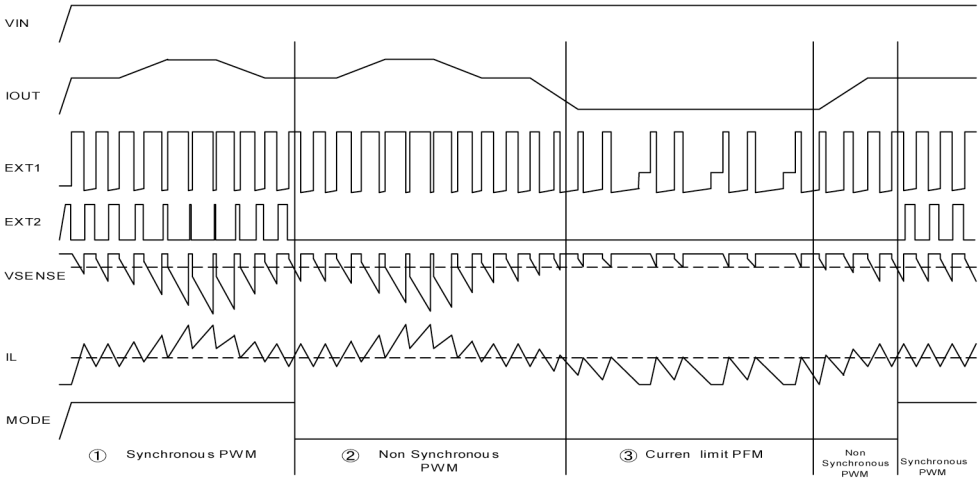
■OPERATIONAL EXPLANATION (Continued)

< Protection Circuit Operation (Current Limit, Latch Protection Circuit, and Short Protection Circuit) >



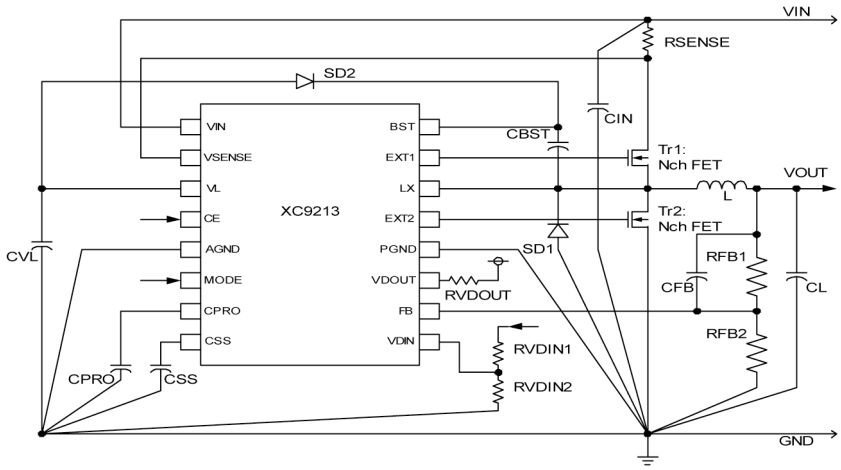
Shown above is a timing chart for protection circuit operations. When the output current changes from normal to an overcurrent condition, the current-limiting circuit detects the overcurrent condition as a voltage drop occurring, by virtue of the current-sensing resistor, at the VSENSE pin. Upon detection, the current-limiting circuit limits the peak current passed through the high-side N-ch MOSFET at every clock pulse (state ①). It is possible to regulate the value of limited current by varying the resistance value of the current-sensing resistor. A protection circuit (protective latch circuit), which is designed to stop the clock, functions if the overcurrent condition continues for a predetermined time (state ②). Time delay before the protective latch circuit functions is adjustable by the capacitance connected to the CPRO pin (typically 4.7 ms if CPRO has 4,700 pF). The protective latch circuit is reset by turning off and on, or by a disable action followed by an enable action using the CE pin. If, furthermore, the output is short-circuited (state ③) and VOUT decreases to a value close to 0 V, the short-circuit protection circuit detects the condition by means of the FB pin and stops the clock with no time delay. The short-circuit protection circuit is reset by turning off and on or by a disable action followed by an enable action using the CE pin, as with the protective latch circuit.

< Mode Control Logic >



A timing chart for automatic switching of current-limiting PFM/PWM is shown above. High-level of the MODE pin allows PWM operations to occur for synchronous rectification (state ①). When the MODE pin shifts to low-level, current-limiting PFM/PWM automatic switching occurs with synchronous rectification stopped. Consequently, the low-side N-ch MOSFET is constantly off under this condition. In addition, a comparison is made for the purposes of automatic switching, between the ON time of the high-side N-ch MOSFET determined by the internal error amp. and the time required for the current passed at every clock pulse through the high-side N-ch MOSFET to reach a preset amount of current. The longer one is selected and becomes on duty (state ② or ③). If the time determined by the error amp. is longer than the other, PWM operation occurs. Current-limiting PFM operation occurs if the time taken by the current passing at every clock pulse to reach a preset amount of current is longer. Thus the automatic switching mechanism achieves high efficiency under light to heavy load conditions.

■TYPICAL APPLICATION CIRCUIT



*Please place CIN close to RSENSE as much as possible, so that an impedance does not occur between the elements.
*Please place CIN, RSENSE, Tr1, Tr2, L, CL, and SD1 as close as possible to each other.

■EXTERNAL COMPONENTS

* Please refer to the DC/DC simulation section of the Torex web site (http//:www.torex.co.jp) for more details.

●Recommended N-ch MOSFETs for Tr1 and Tr2

●IOUT : Less than 3A

PART NUMBER	MANUFACTURER	TYPE	Ciss (pF)	Crss (pF)	Crss / (Ciss + Crss)
uPA2751GR	NEC	Dual	1040	130	0.111
IRF7313	International Rectifier	Dual	650	130	0.167

●IOUT : More than 3A

PART NUMBER	MANUFACTURER	TYPE	Ciss (pF)	Crss (pF)	Crss / (Ciss + Crss)
SUD30N03	Vishay	Single	1170	30	0.049
SUD70N03	Vishay	Single	2700	360	0.118

* It is recommended to use MOSFETs with Ciss less than 3000pF.

* For Tr2, MOSFETs with smaller Crss / (Ciss + Crss) are recommended.

●Recommended Coil (L)

PART NUMBER	MANUFACTURER
CDRH127/LD-7R4	SUMIDA
CDRH127-6R1	SUMIDA

* For stable operation, please use a coil with L less than 22 μ H.

●Recommended Capacitor (CIN, CVL, CBST, CL)

COMPONENTS	PART NUMBER	MANUFACTURER	TYPE	VALUE	PCS
CIN (*1)	-	-	Ceramic	10 μ F	2
	25SC22M	SANYO	OS	22 μ F	1
CVL	-	-	Ceramic	1 μ F	1
CBST	-	-	Ceramic	1 μ F ~ 4.7 μ F	1
CL (*2)	20SS150M	SANYO	OS	150 μ F	1
	25PS100JM12	NIPPON CHEMI-CON	-	100 μ F	

(*1)Please place CIN close to RSENSE as much as possible, so that an impedance does not occur between the elements.
A 1μF ceramic capacitor is recommended for CVL.
(*2)Operation may become unstable if a ceramic capacitor is used for CL.

■EXTERNAL COMPONENTS (Continued)

●Output Voltage Setting (RFB1, RFB2, CFB)

Output voltage can be set by adding external split resistors. Output voltage is determined by the following equation, based on the values of RFB1 and RFB2. The sum of RFB1 and RFB2 should normally be 2 MΩ or less *(RFB1 + RFB2≦2MΩ)*.

VOUT = RFB1 / RFB2 + 1

The value of CFB, speed-up capacitor for phase compensation, should be adjusted by the following equation.

fzfb= 1 / (2 x π x CFB x RFB1) ≒10kHz

Adjustments are required from 1kHz to 50kHz depending on the application, value of inductance (L), and value of load capacity (CL).

ex.) Output voltage setting

VOUT (V)	RFB1 (Ω)	RFB2 (Ω)	CFB (pF)
1.5	150	300	100
1.8	160	200	100
2.5	360	240	47
3.0	220	110	47
3.3	620	270	27
5.0	300	75	47

●Recommended Schottky Diode (SD1, SD2)

SYMBOL	PART NUMBER	MANUFACTURER
SD1	CMS02	TOSHIBA
	DE5PC3	SHINDENGEN
SD2	XB01SB04A2BR	TOREX
	CRS02	TOSHIBA

* SD1 and SD2 should be of favorable reverse-current characteristics. If, in particular, SD2 has poor reverse-current characteristics, CBST cannot be fully charged at high temperatures, resulting, in some cases, in failure to drive Tr1.

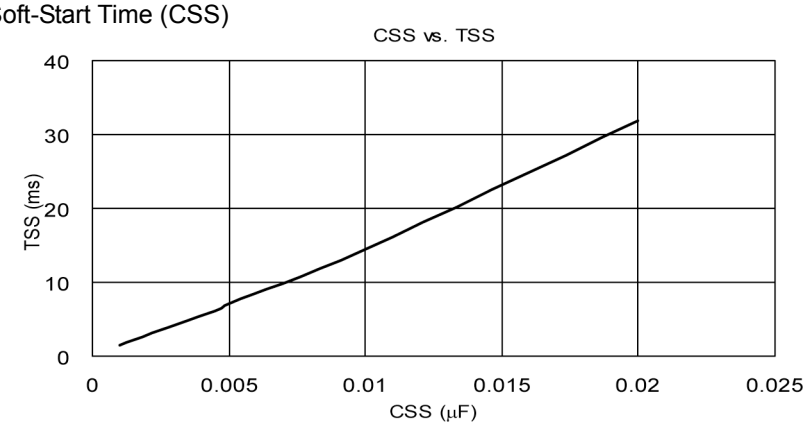
●Setting Latch Protection Circuit Delay Time (CPRO)

Time delay is 4.7 ms (TYP.) under the current conditions if CPRO has 4,700 pF. This time delay is roughly proportional to the value of CPRO.

ex.) When CPRO is 2200pF, 4.7ms (TYP.) x 2200pF / 4700pF =2.2ms (TYP.)
When CPRO is 0.01μF (10,000pF), 4.7ms (TYP.) x 10000pF / 4700pF =10ms (TYP.)

* For stable operation, please use a capacitor with more than 2200pF as CPRO.

●Setting Soft-Start Time (CSS)



Relationships between the value of CSS and the soft-start time (25°C TYP.) are shown at left. For stable operation, please use a capacitor with more than 2200pF as CSS.

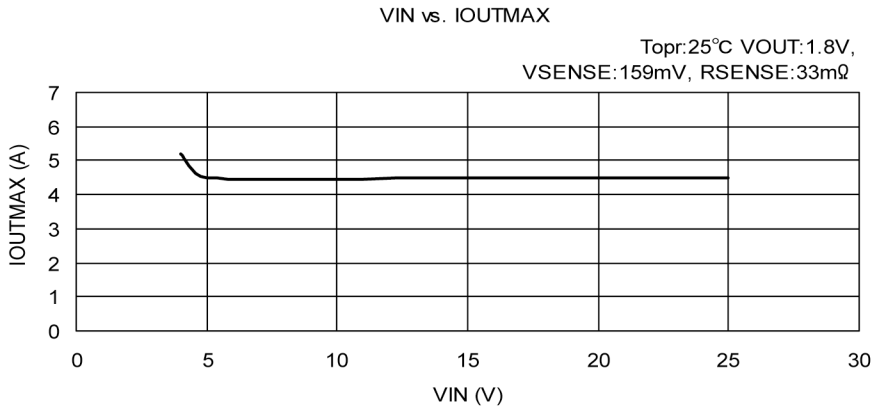
■EXTERNAL COMPONENTS (Continued)

●Sense Resistance (RSENSE)

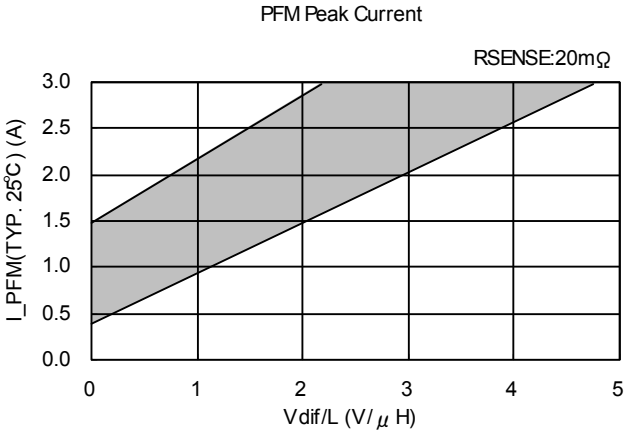
The below values can be adjusted by using sense resistance (RSENSE).

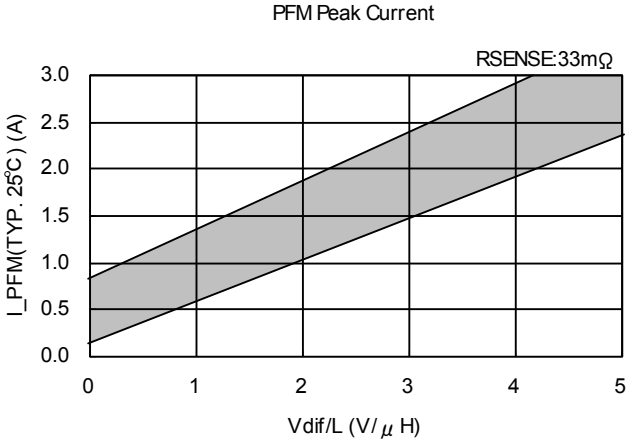
It is recommended using the RSENSE value in the range of 20mΩ to 100mΩ.

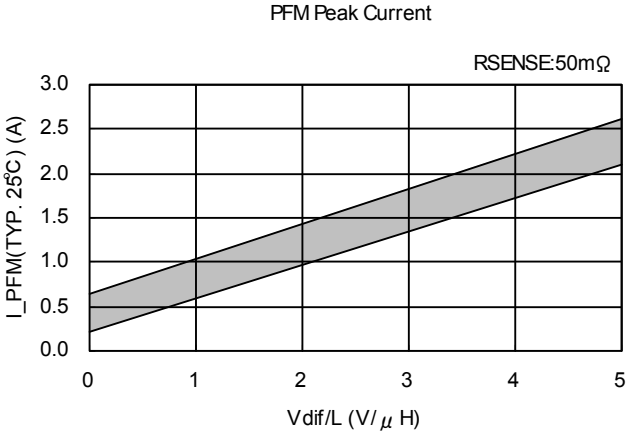
1) Detect current value of the overcurrent detect circuit
Maximum output current (IOUTMAX) can be adjusted as the equation below.
IOUTMAX (A) ≒ 200mV (MAX.) / RSENSE (mΩ)
When 4V≦VIN＜5V, the maximum output current becomes larger than the calculated value.
Please also refer to the characteristics performance below.



2) Peak current value of the current limit PFM control
Peak current value of the current limit PFM control (I_PFM) varies depending on the dropout voltage (VDIF), the coil (L) value and the sense resistance value (RSENSE). For the XC9213 series' sample with voltage sense (VSENSE) 170mV, the characteristic performance below shows the changes in the peak current (I_PFM) when the sense resistance values (RSENSE) are 20mΩ, 33 mΩ, and 50 mΩ. The peak current varies according to the dropout voltage and the coil value.







The sense voltage varies within the range of 145 mV≦VSENSE≦200mV.
The peak current as shown in three graphs fluctuates
according to the sample's sense voltage.

■EXTERNAL COMPONENTS (Continued)

●Divided Resistors For VD Input Voltages (RVDIN1, RVDIN2)

Detect voltage of the detector block can be adjusted by the external divided resistors for VD input voltages (RVDIN1, RVDIN2) as the equation below.

When *0.855V ≦ VDF ≦ 0.925V (0.9V TYP.)*

Detect voltage = VDF x (RVDIN1 + RVDIN2) / RVDIN2 [V]

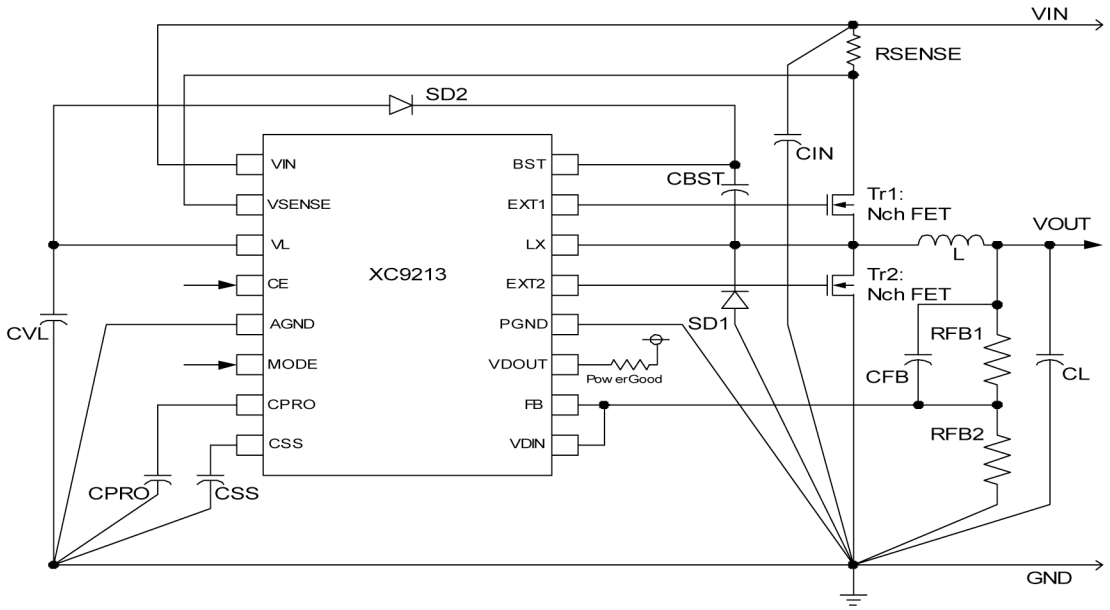
Please select RVDIN1 and RVDIN2 as the sum of RVDIN1 and RVDIN2 becomes less than 2MΩ.

●Divided Resistor For VD Output Voltage (RVDOUT)

Output type of the detector block is N-channel open drain. Please use a 1kΩ resistor or more as RVDOUT.

■APPLICATION CIRCUIT EXAMPLE

The application circuit shown below is the example for using the detector block as power good.
Please connect the VDIN pin with the FB pin as below.



■NOTES ON USE

1. Overcurrent Limit Function

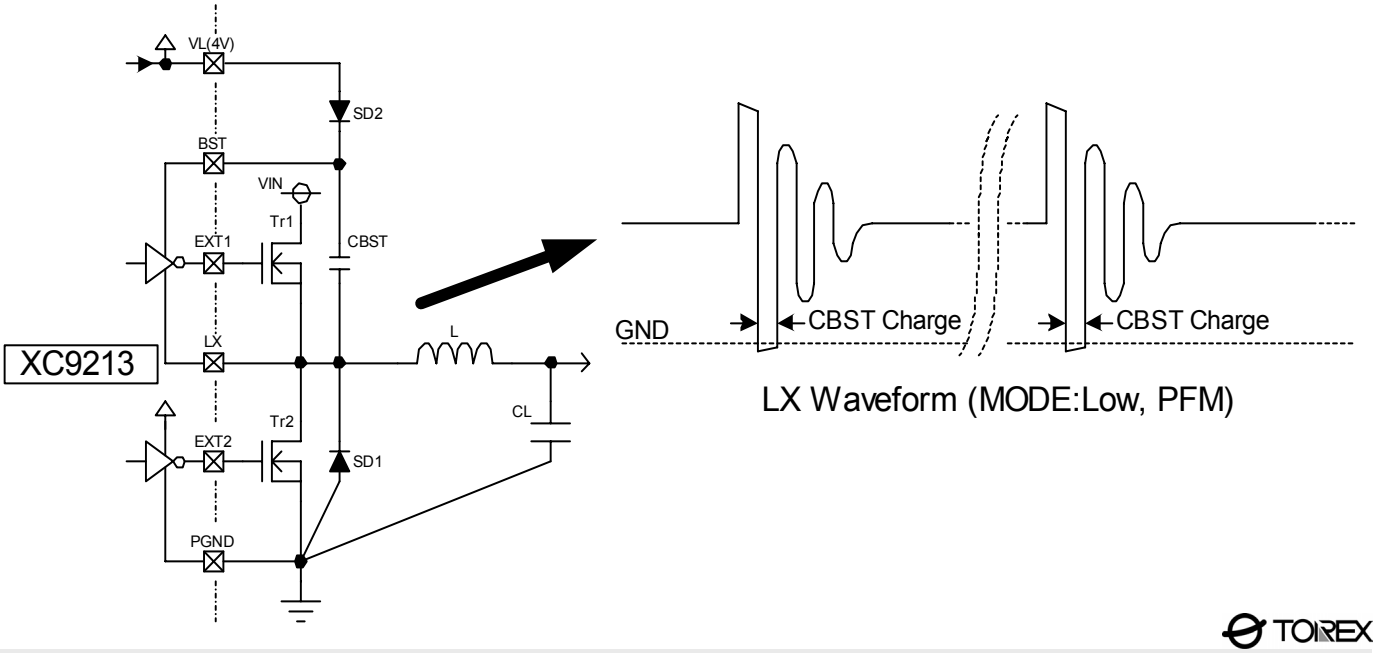
The internal current detection circuit is designed to monitor voltage occurs between RSENSE resistors in the overcurrent condition. In case that the overcurrent limit function operates when the output is shorted, etc., the current detection circuit detects that the voltage between RSENSE resistors reaches the SENSE voltage (170mV TYP.), and, thereby, the overcurrent limit circuit outputs the signal, which makes High side's N-ch MOSFET turn off. Therefore, delay time will occur (300ns TYP.) after the current detection circuit detects the SENSE voltage before High side's N-ch MOSFET turns off. When the overcurrent limit function operates because of rapid load fluctuation etc., the SENSE voltage will spread during the delay time without being limited at the voltage value, which is supposed to be limited. Therefore, please be noted to the absolute maximum ratings of external MOSFET, a coil, and an Schottky diode.

2. Short Protection Circuit

In case that a power supply is applied to the IC while the output is shorted, or the IC is switched to enable state from disable state via the CE pin, when High side's N-ch MOSFET is ON and Low side's N-ch MOSFET is OFF, the potential difference for input voltage will occur to the both ends of a coil. Therefore, the time rate of coil current becomes large. By contrast, when High side's N-ch MOSFET is OFF and Low side's N-ch MOSFET is ON, there is almost no potential difference at both ends of the coil since the output voltage is shorted to the Ground. For this, the time rate of coil current becomes quite small. This operation is repeated within soft-start time; therefore, coil current will increase for every clock. Also with the delay time of the circuit, coil current will be converged on a certain current value without being limited at the current amount, which is supposed to be limited. However, step-down operation will stop and the circuit can be latched if FB voltage is decreasing to the voltage level, which enables to operate a short protection circuit when the soft-start time completes. Even if the FB voltage is not decreasing to the voltage level, which a short protection circuit cannot be operated, the step-down operation stops when CPRO time completes, and the circuit will be latched.
Please be noted to the absolute maximum ratings of external MOSFET, a coil, and an Schottky diode.

3. Current Limit PFM Control

With a built-in bootstrap buffer driver circuit, the 9213 series generates voltage for Tr1 to be turned on by charging CBST with VL (4V). When Tr1 is off, Tr2 is on, and the Lx signal is low, it will be suitable timing for charging CBST. (Please refer to the above figure.) For that reason, at PFM control (MODE: Low), the clock pulses will decrease extremely according to the decrease of the load current. As a result, it will cause a decrease of charging frequency and an electric discharge of CBST so that sufficient voltage for the Tr1 to be turned on will not be supplied.
Therefore,
1) Please use a Schottky Barrier Diode with few reverse current values for SD2.
2) Please avoid extreme light loads (e.g. less than a few mA)
Moreover, the above-mentioned operation may occur, influenced by external components including SD2 and ambient temperature. It's recommended to use the IC after evaluation with an actual device.



■NOTES ON USE (Continued)

4. Switching on and off the IC by the input voltage pin

When the IC is switched on and off by the input voltage pin (VIN) instead of the chip enable pin (CE), the IC may stop operation because a protection circuit built inside the short-protection circuit, etc. begins to work in order to block ON signal which is sent before the soft-start capacitor connection pin (CSS) resets. The following methods can be used for avoiding this situation;

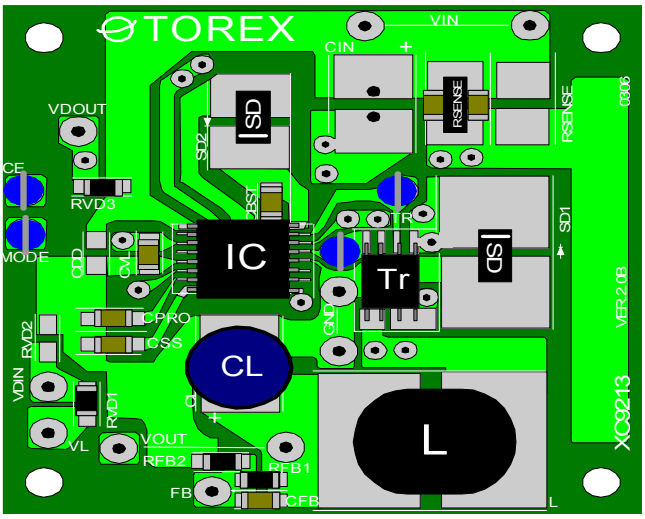
a) Turn on the power source again after input voltage becomes below U.V.L.O. detect voltage (1.0V MIN.), furthermore, after the lapse of the time constant of τ =CSS x 50k.

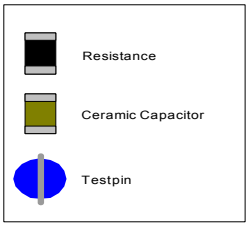
b) Before turning the power source on again, start-up the IC after resetting the CSS forcibly and keeping soft-start time.

Please make sure the CSS pin is discharged once and the soft-start time is secured when starting up the IC.

■RECOMMENDED PCB LAYOUT

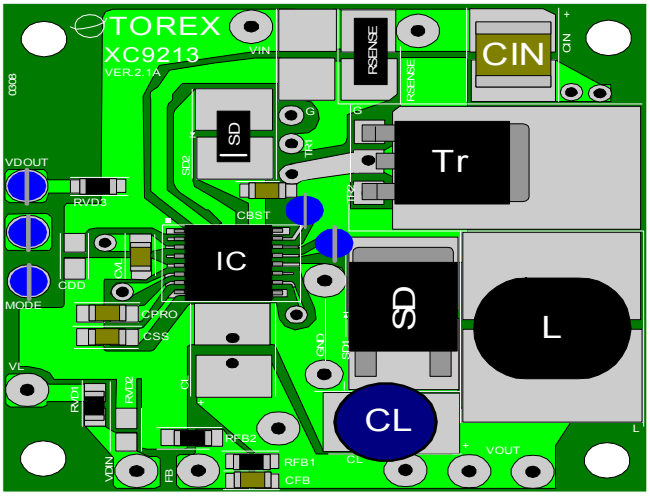
●Layout For Using a Dual MOSFET

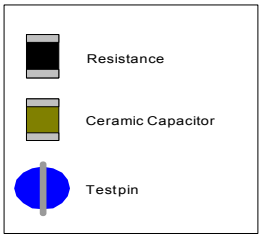




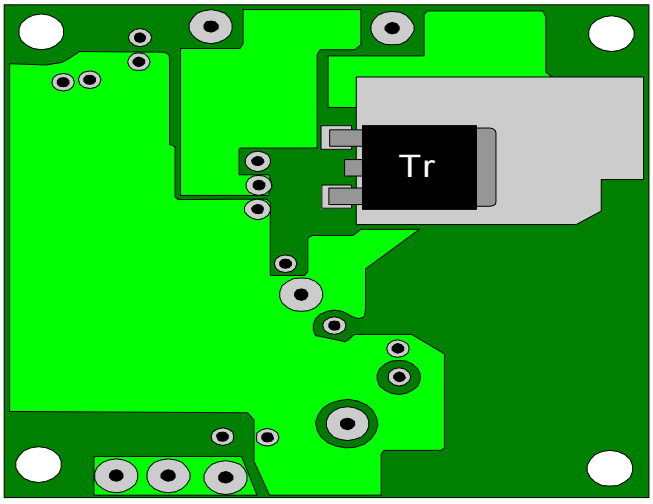
●Layout For Using a Single MOSFET

<TOP VIEW>





<BOTTOM VIEW>



* Please use tinned wires etc. for the VIN, the VOUT, and the GND.

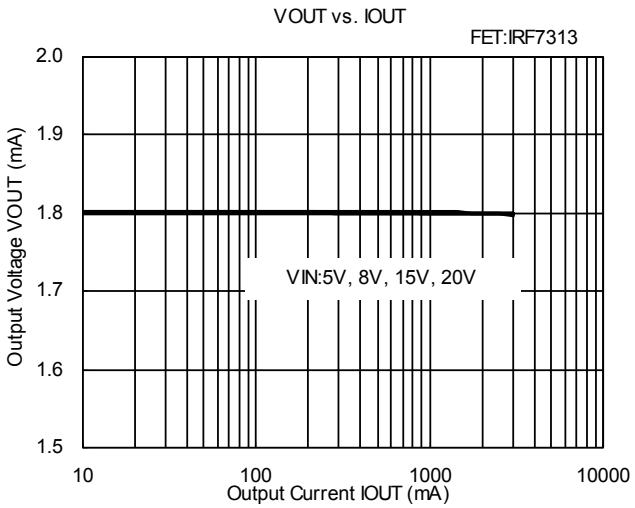
** Please attach test pins etc. to the CE, the MODE, the EXT, and the EXT2.

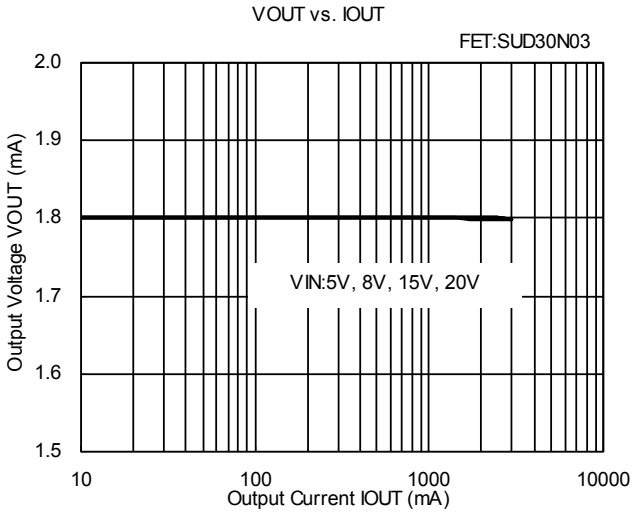
*** Please solder mount the RSENSE and the CE as close as possible.

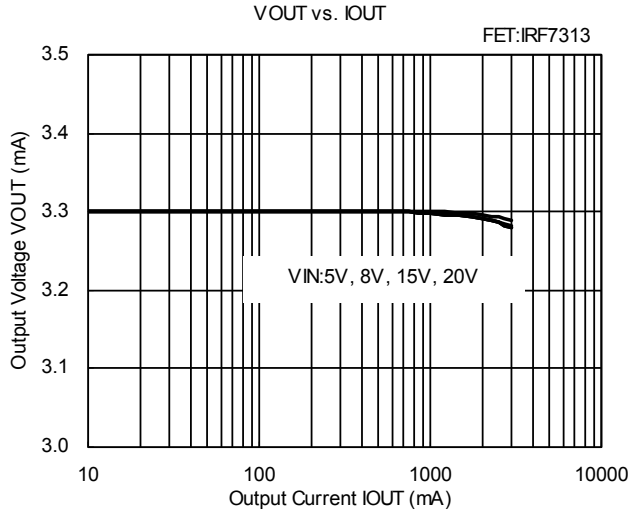
■TYPICAL PERFORMANCE CHARACTERISTICS

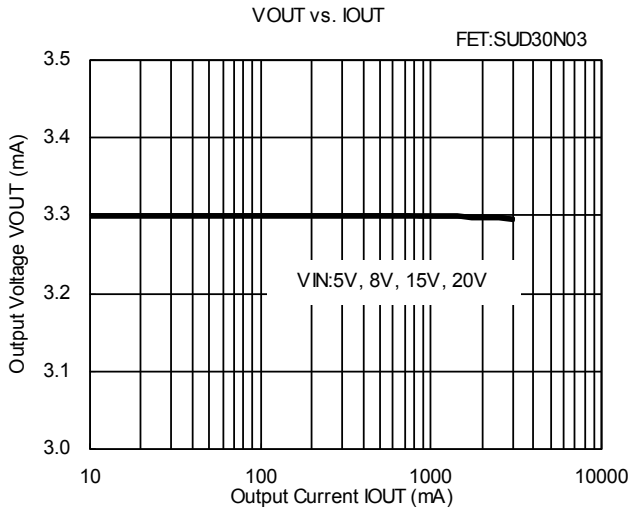
(Unless otherwise stated, Topr:25℃)

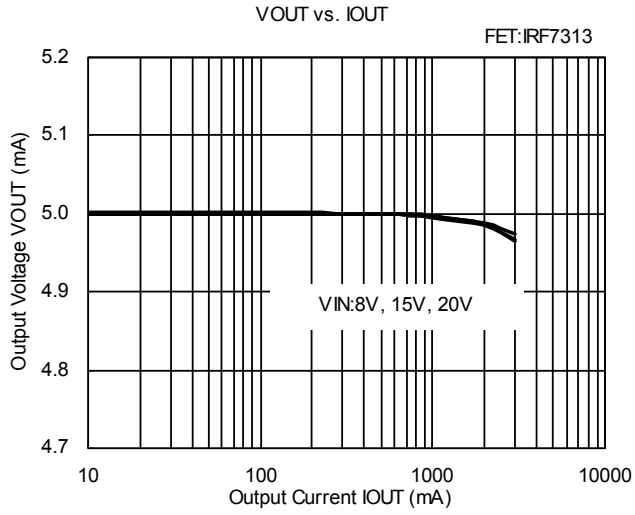
(1) Output Voltage vs. Output Current <MODE: High>

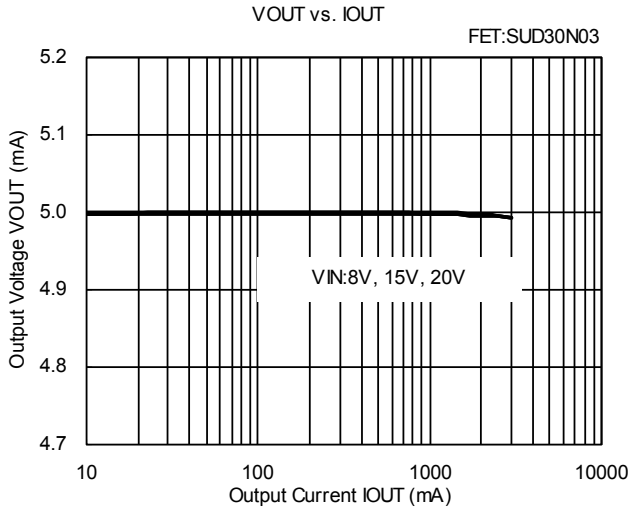






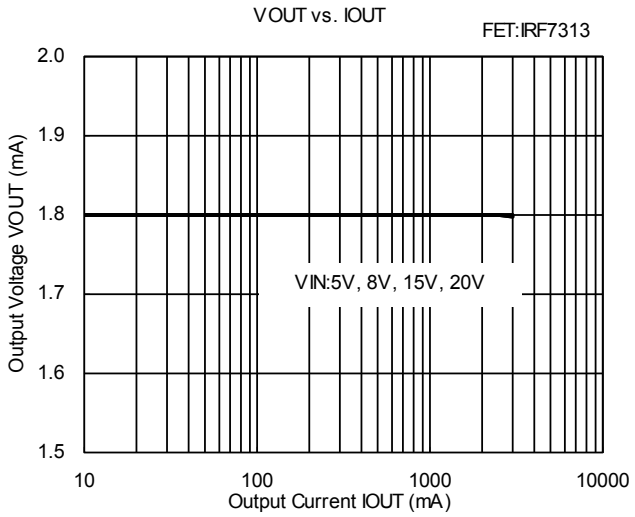


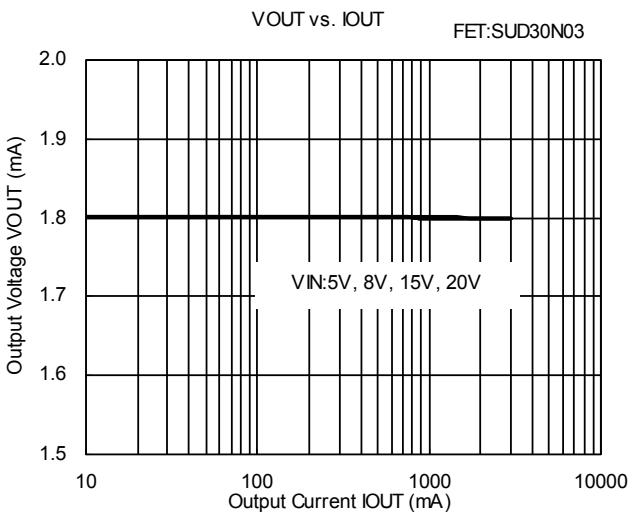


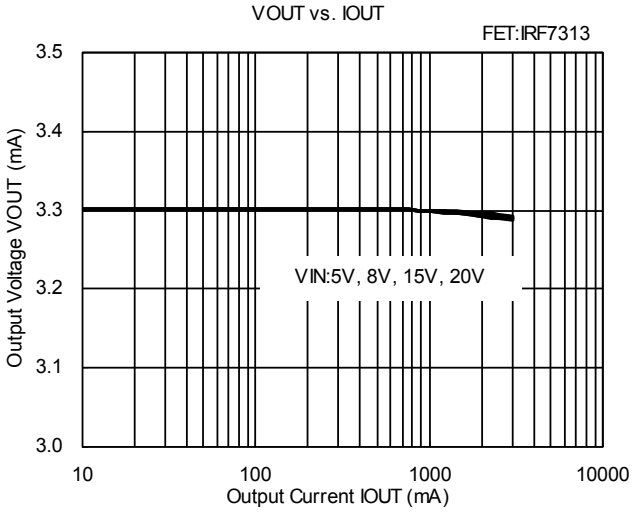


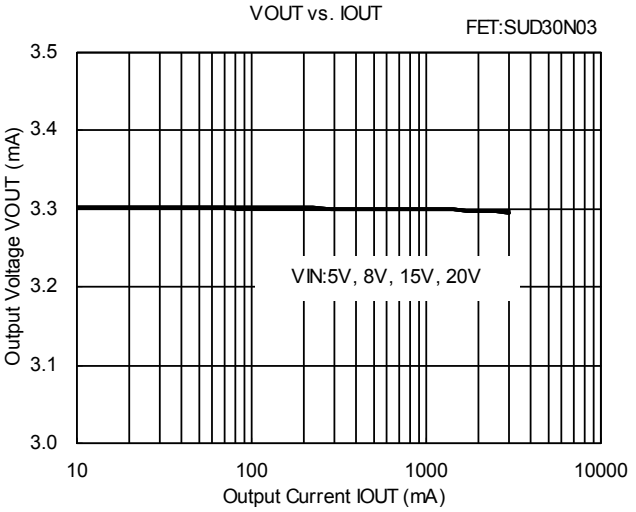
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

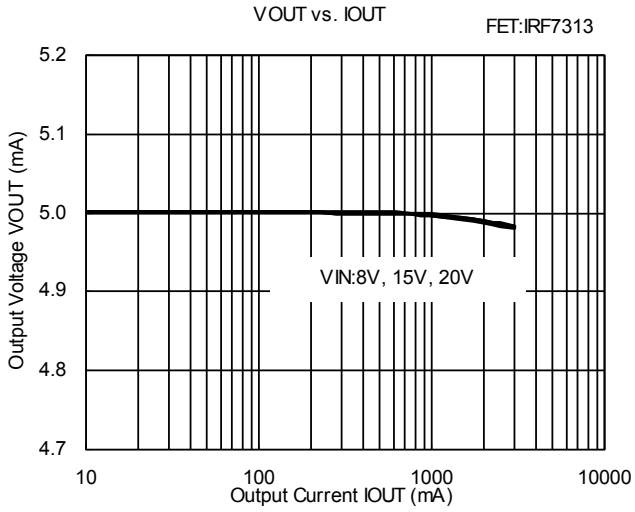
(2) Output Voltage vs. Output Current <MODE: Low>

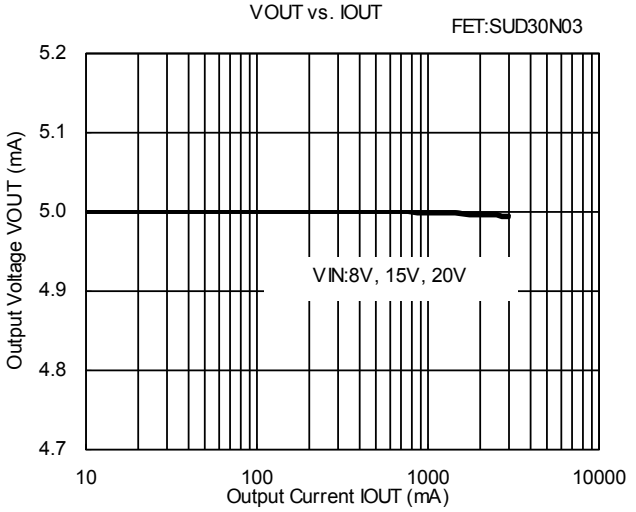






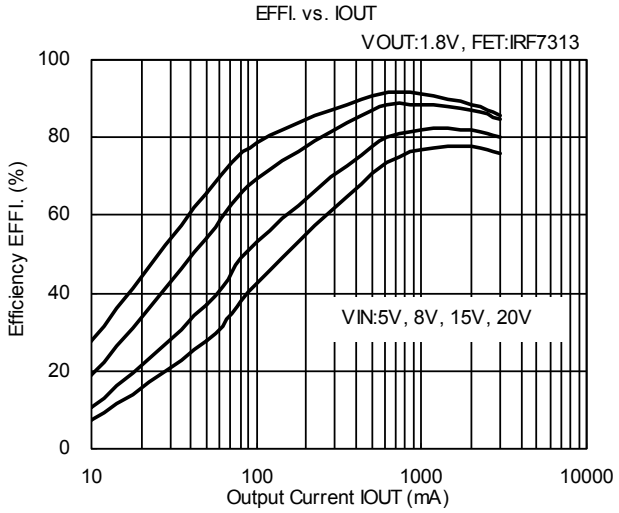


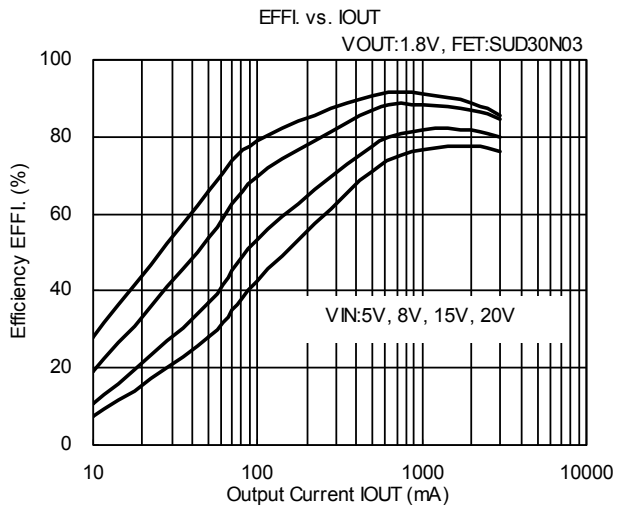


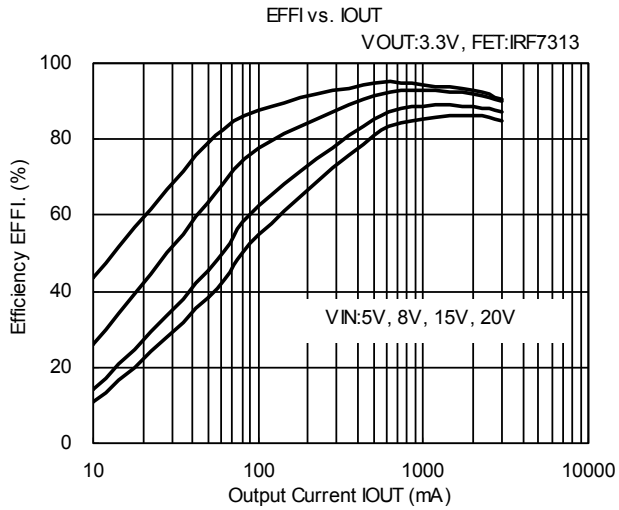


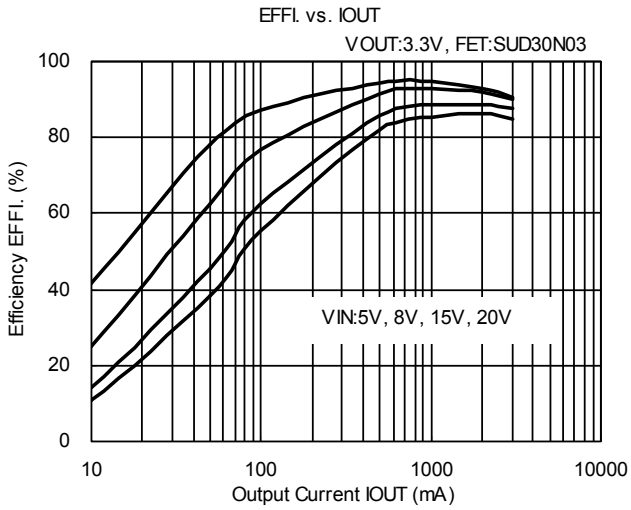
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

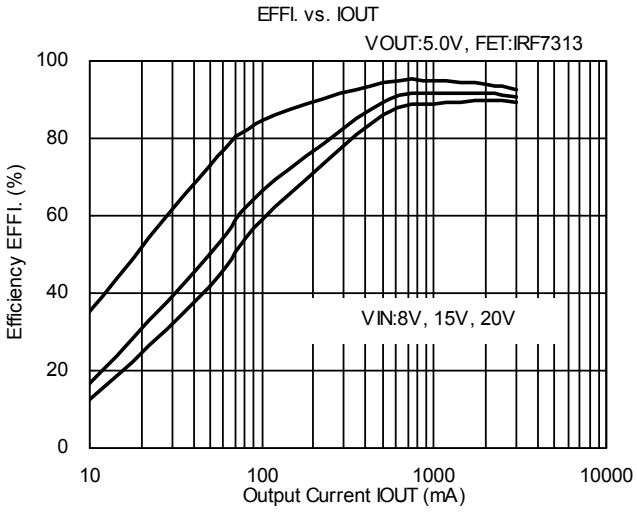
(3) Efficiency vs. Output Current <MODE: High>

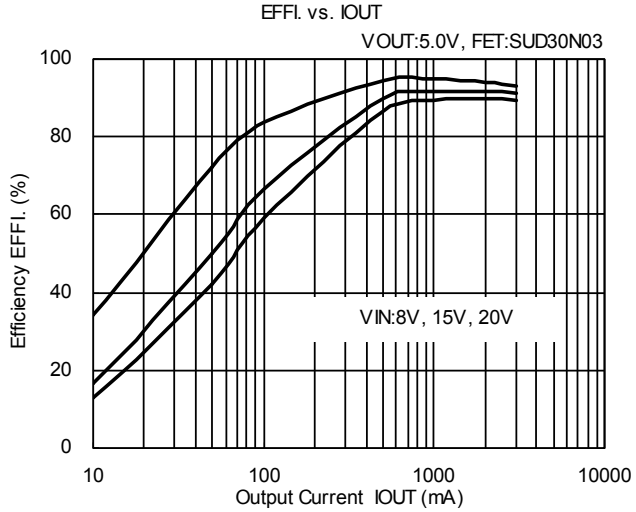






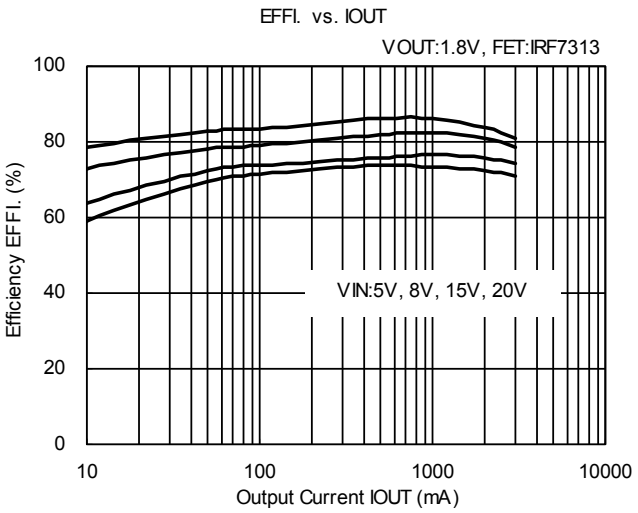


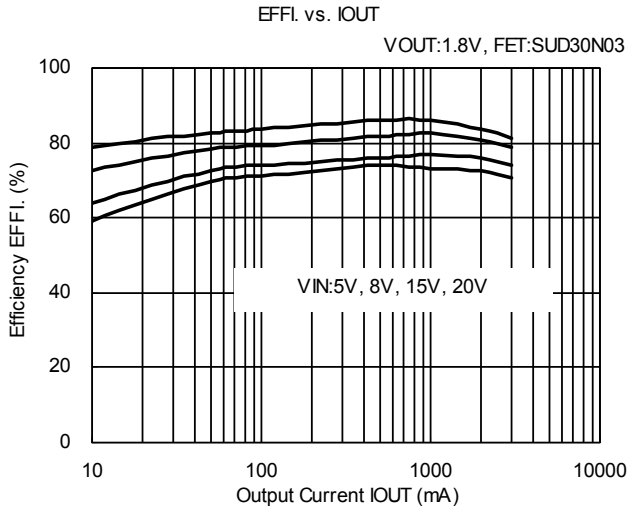


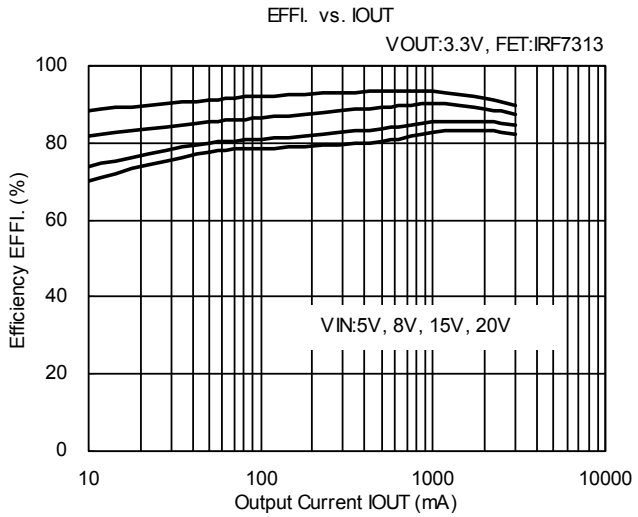


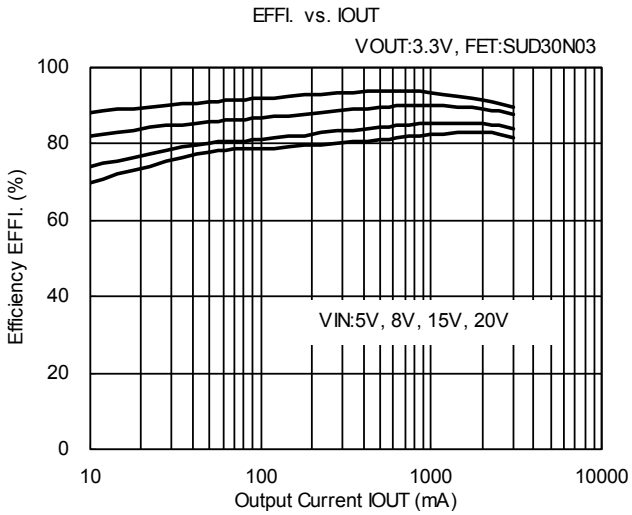
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

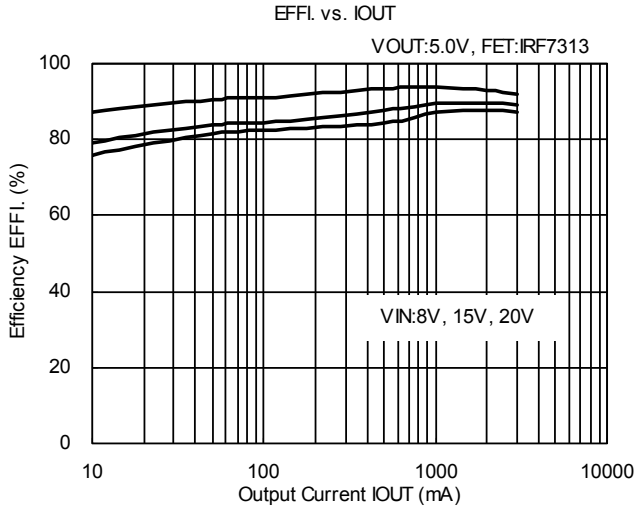
(4) Efficiency vs. Output Current <MODE: Low>

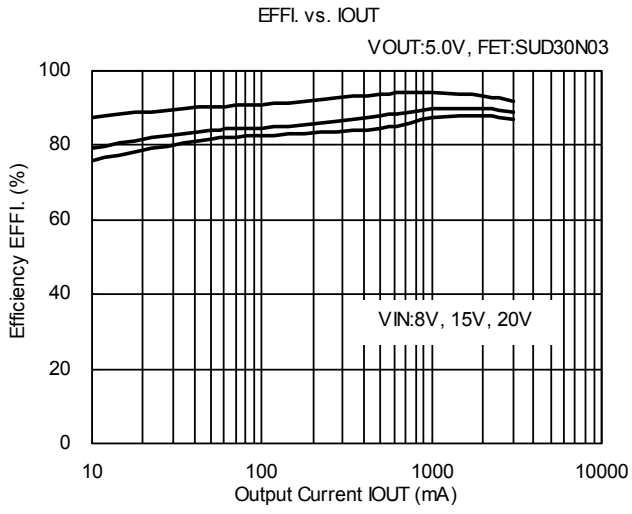






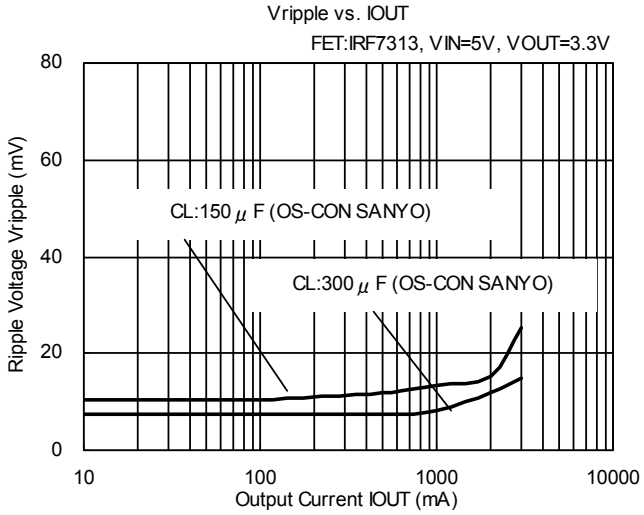


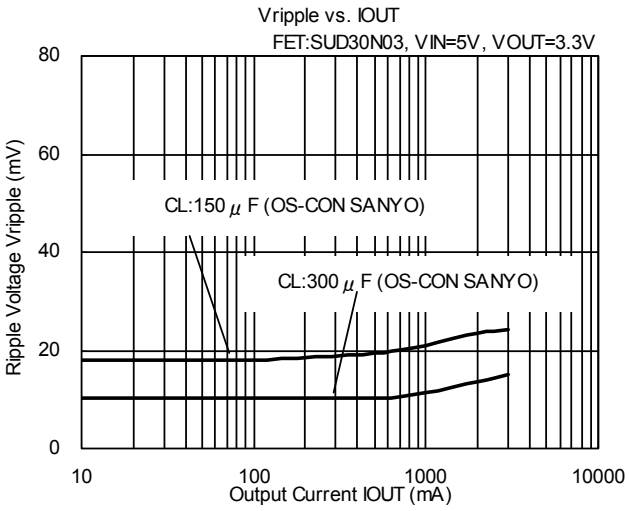


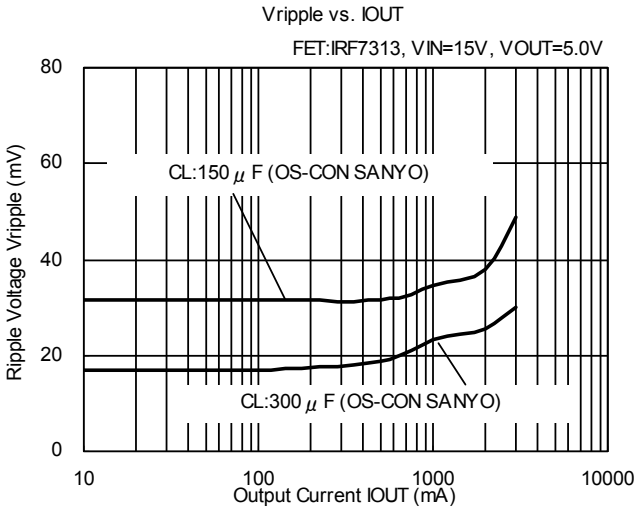


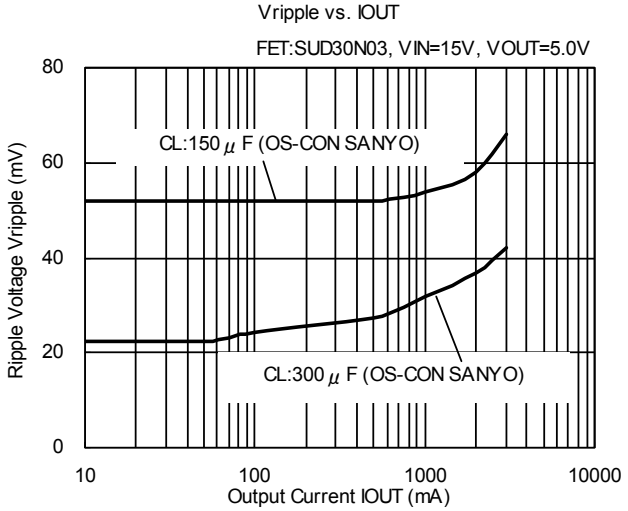
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(5) Ripple Voltage vs. Output Current <MODE: High, Coil: CDRH127/LD-7R4>

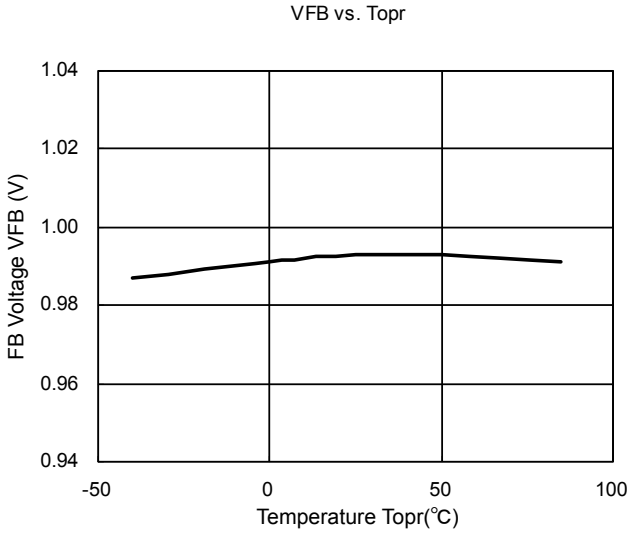


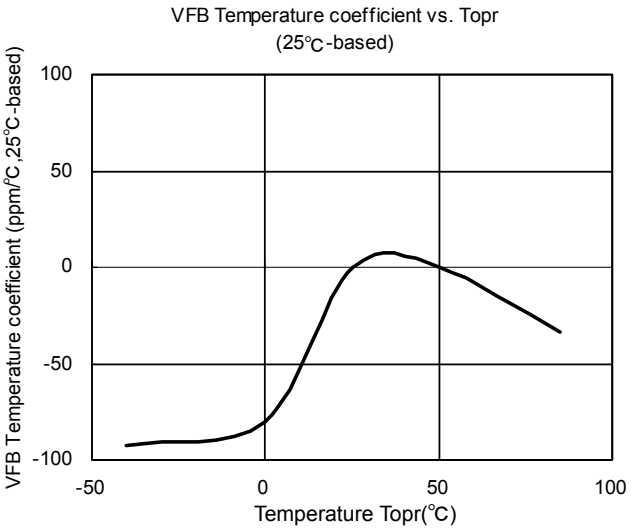






(6) FB Voltage Temperature Characteristics

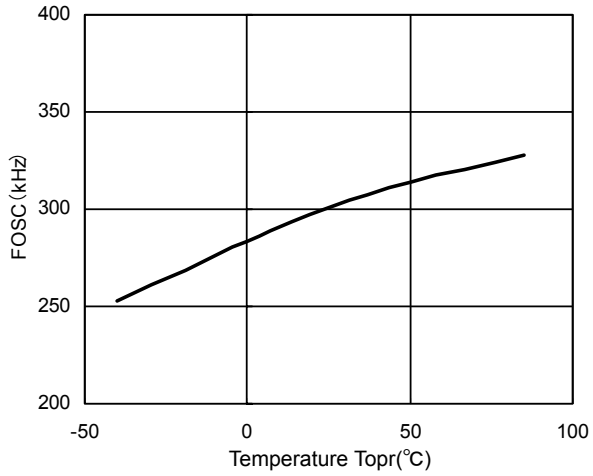




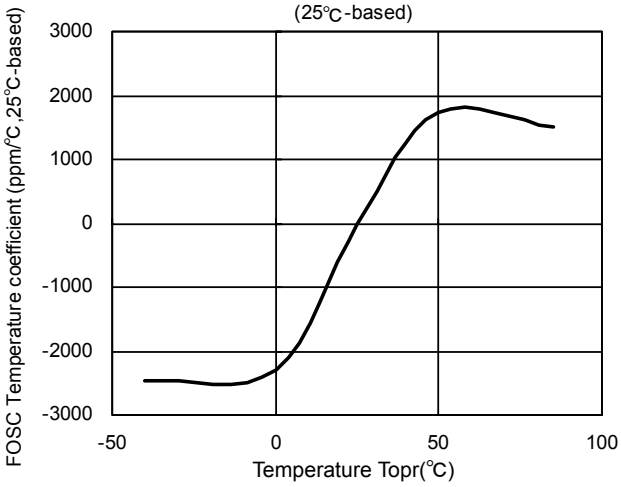
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Oscillation Frequency Temperature Characteristics

FOSC vs. Topr

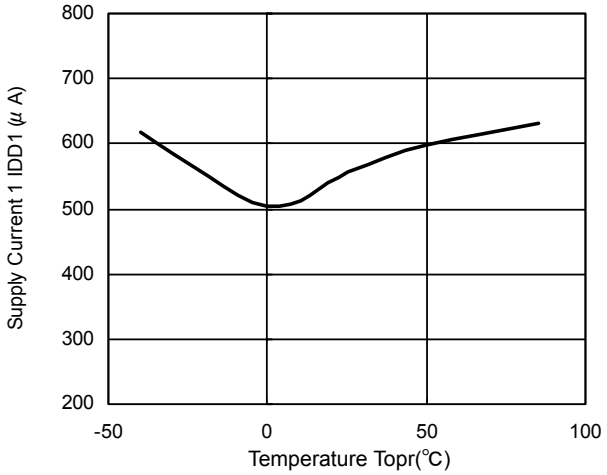


FOSC Temperature Coefficient vs. Topr
(25℃-based)

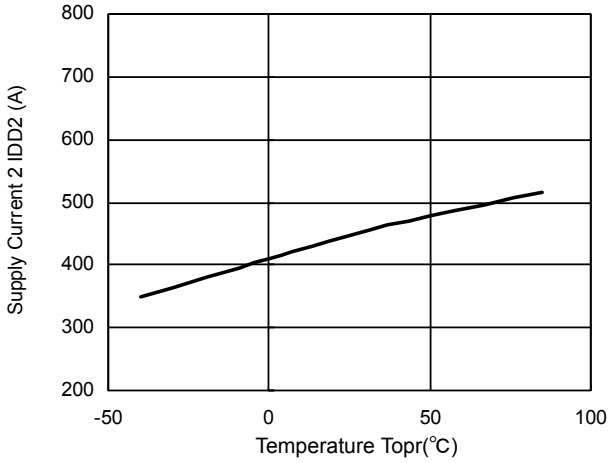


(8) Supply Current 1 & 2 Temperature Characteristics

IDD1 vs. Topr

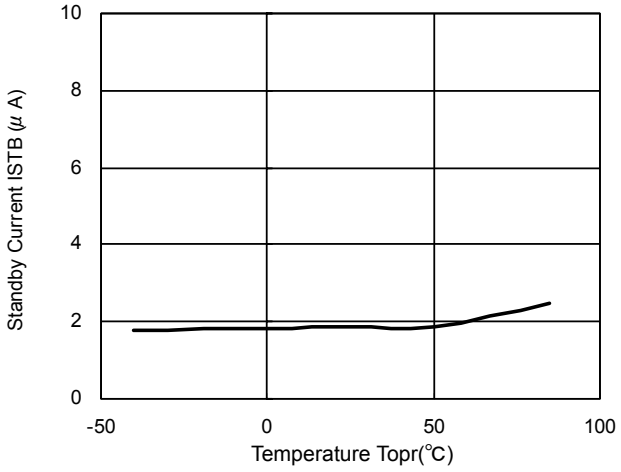


IDD2 vs. Topr



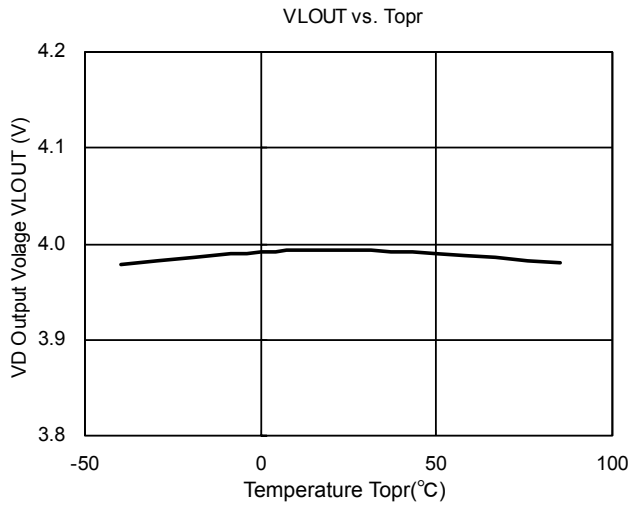
(9) Standby Current Temperature Characteristics

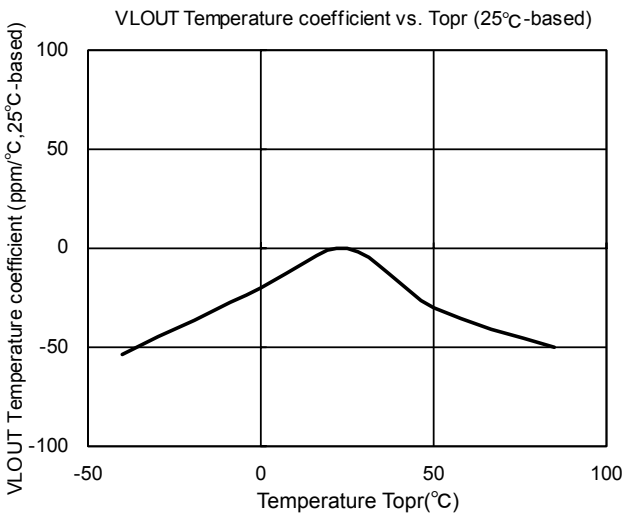
ISTB vs. Topr



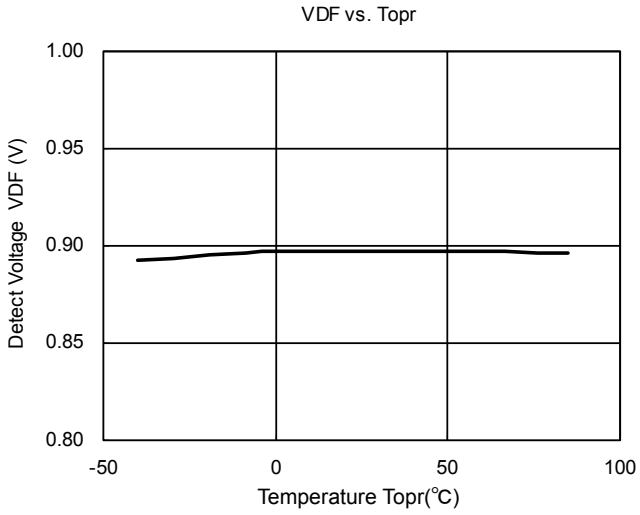
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(10) VR Output Voltage Temperature Characteristics

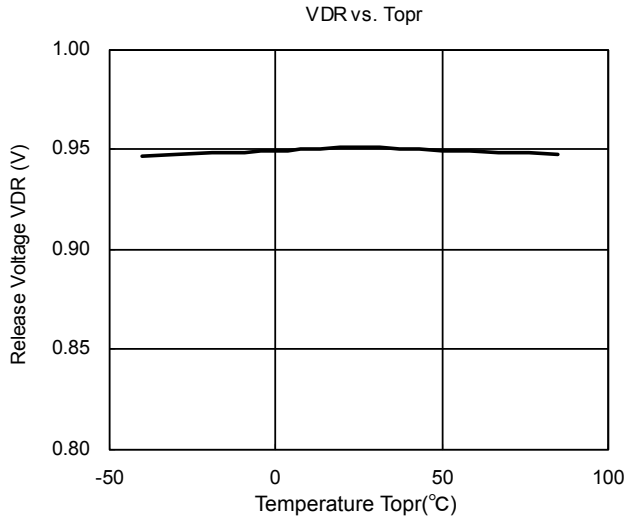




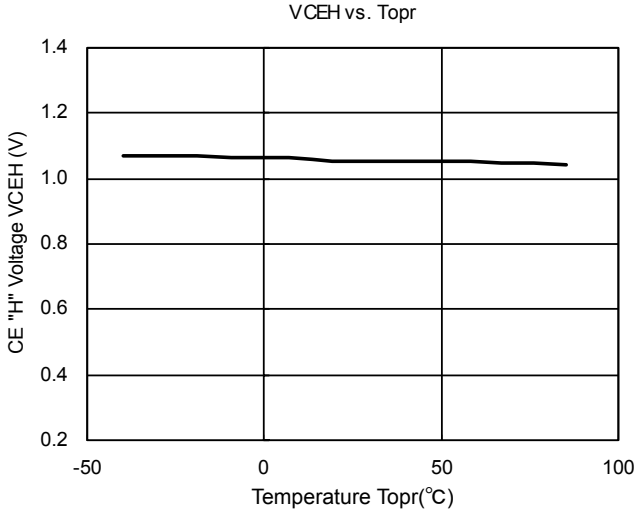
(11) VD Detect Voltage Temperature Characteristics

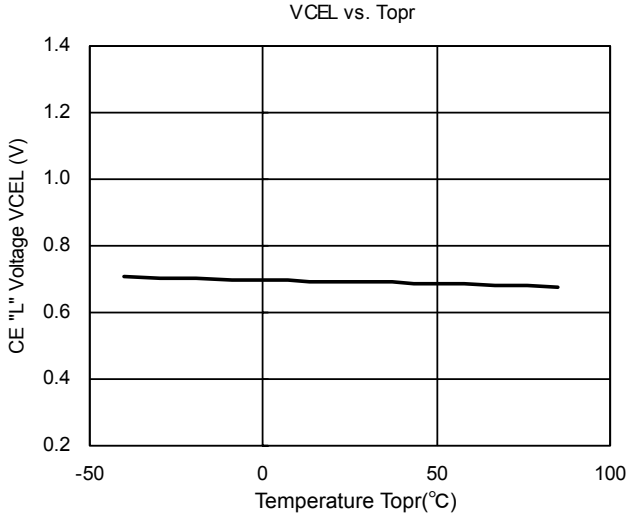


(12) VD Release Voltage Temperature Characteristics



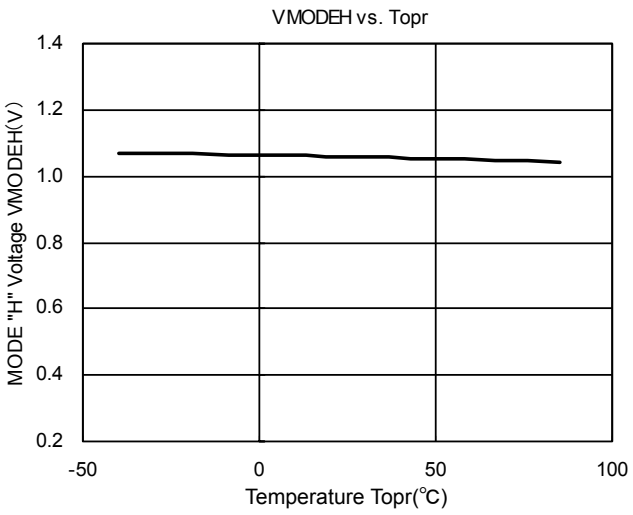
(13) CE "H", "L" Voltage Temperature Characteristics

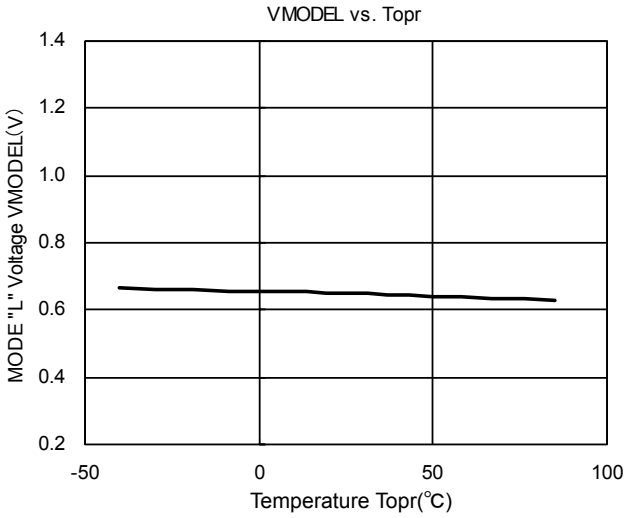




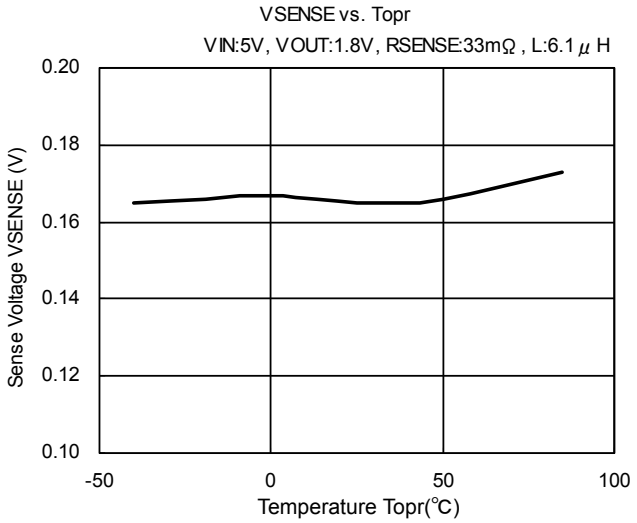
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(14) MODE "H", "L" Voltage Temperature Characteristics

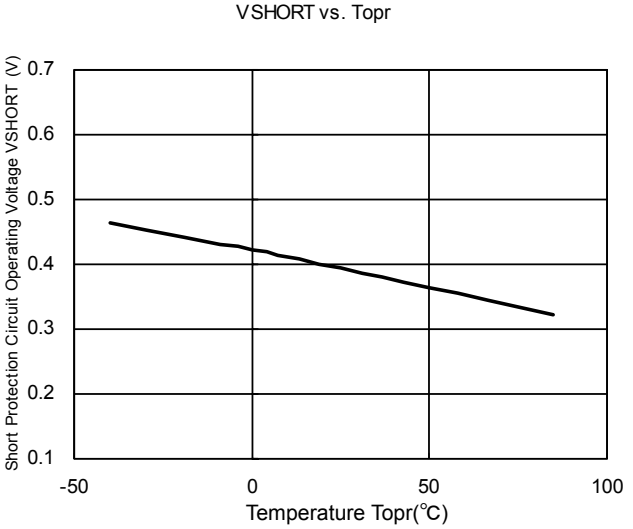




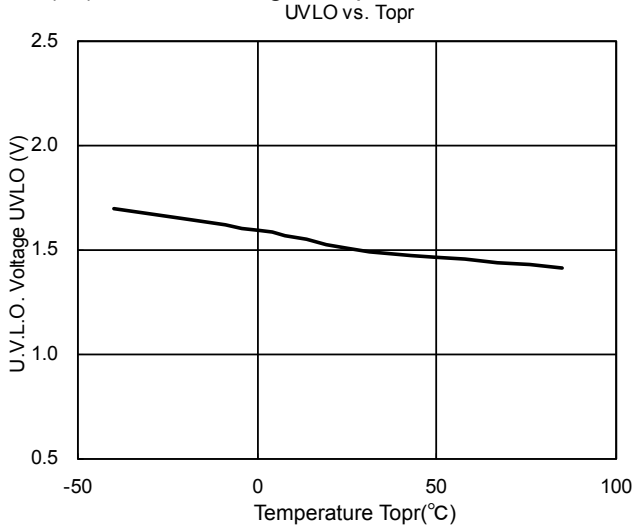
(15) Sense Voltage Temperature Characteristics



(16) Short Protection Circuit Operation Voltage Temp. Characteristics



(17) U.V.L.O. Voltage Temperature Characteristics



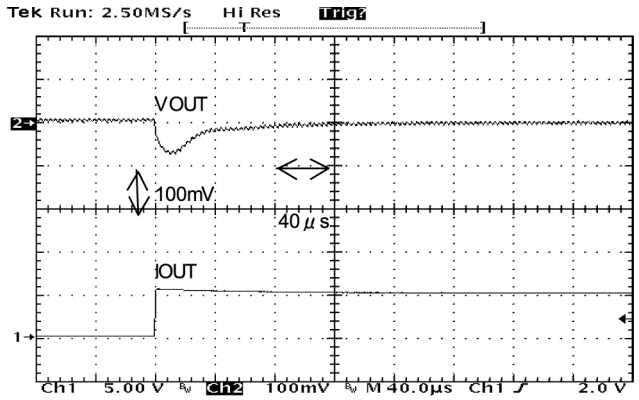
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

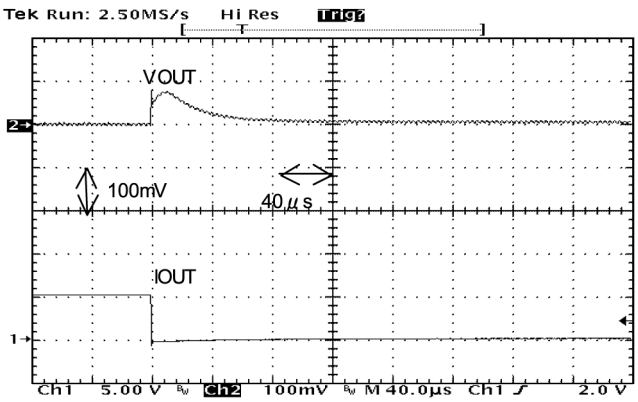
(18) Load Transient Response Characteristics <MODE: High>

<Condition>
VIN: 5V
VOUT: 1.8V
IOUT:0A⇔1A

MODE: High
FET:IRF7313 (International Rectifier)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)

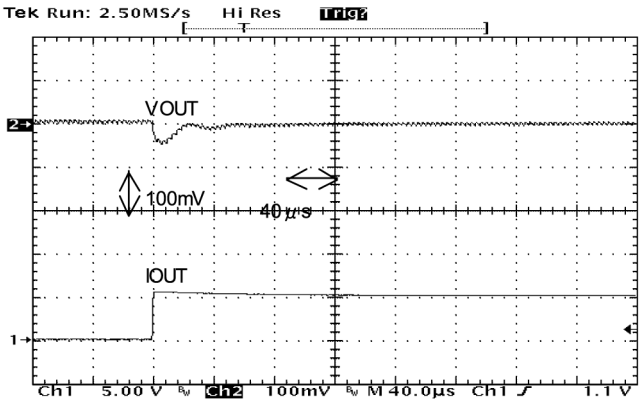


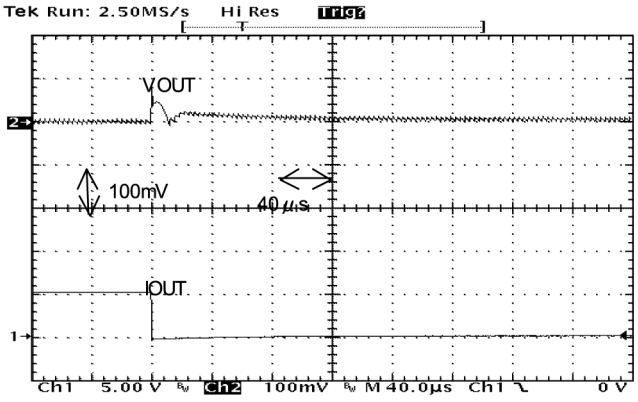


<Condition>
VIN: 15V
VOUT: 1.8V
IOUT:0A⇔1A

MODE: High
FET:IRF7313 (International Rectifier)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)

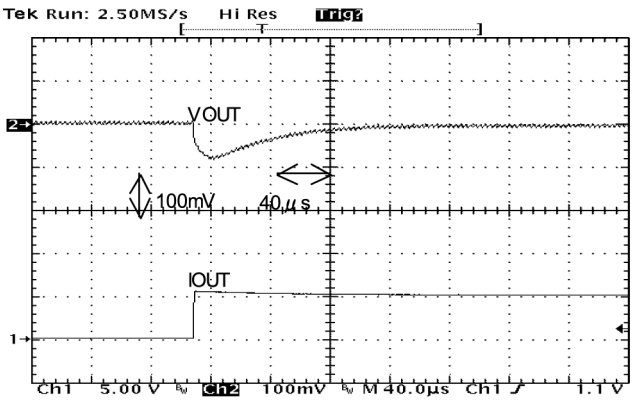


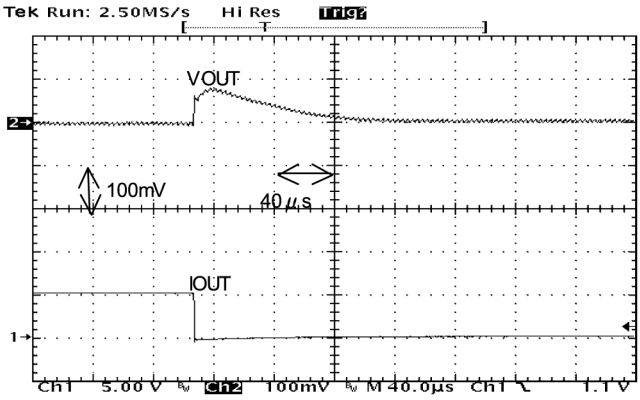


<Condition>
VIN: 5V
VOUT: 3.3V
IOUT:0A⇔1A

MODE: High
FET:IRF7313 (International Rectifier)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)





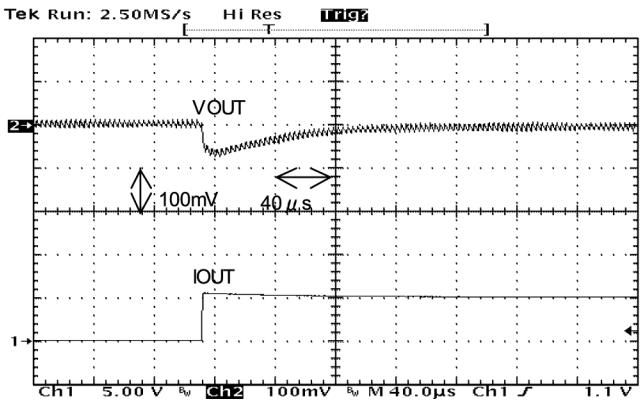
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

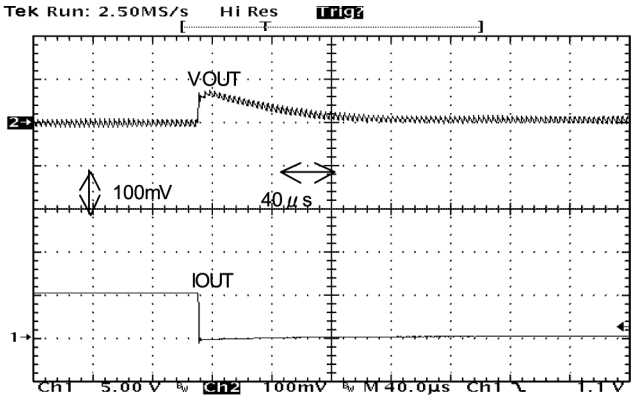
(18) Load Transient Response Characteristics <MODE: High> (Continued)

<Condition>
VIN: 15V
VOUT: 3.3V
IOUT:0A⟷ 1A

MODE: High
FET:IRF7313 (International Rectifier)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)

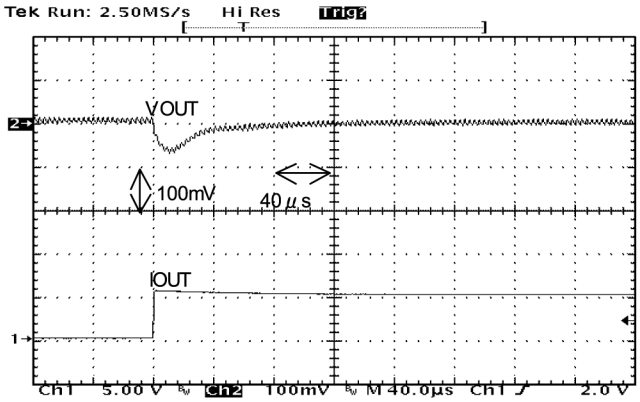


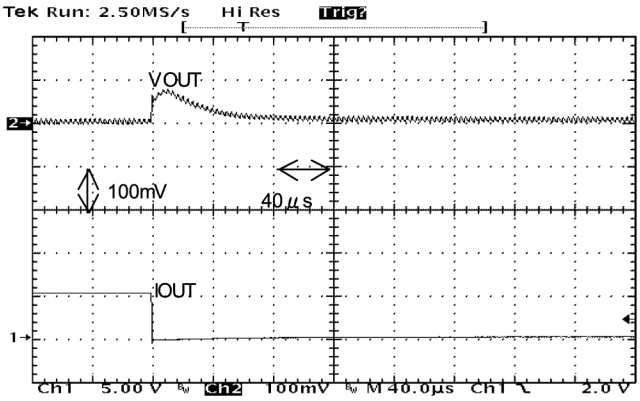


<Condition>
VIN: 5V
VOUT: 1.8V
IOUT:0A⟷ 1A

MODE: High
FET: SUD30N03 (Vishay)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)

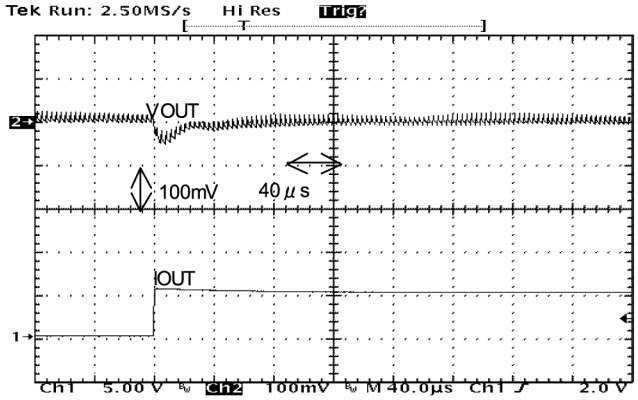


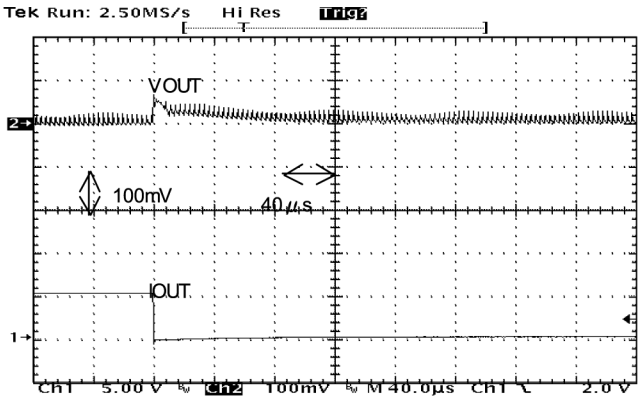


<Condition>
VIN: 15V
VOUT: 1.8V
IOUT:0A⟷ 1A

MODE: High
FET:SUD30N03 (Vishay)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)





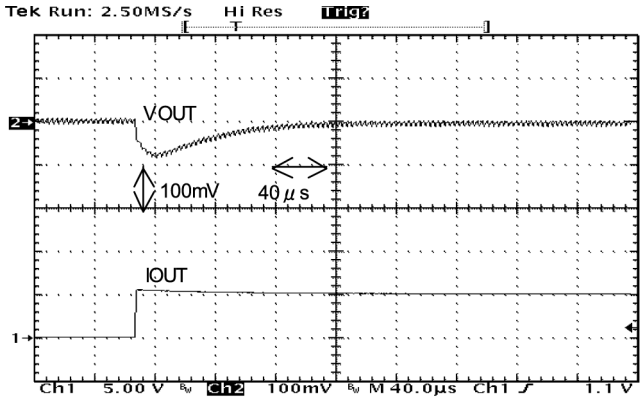
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

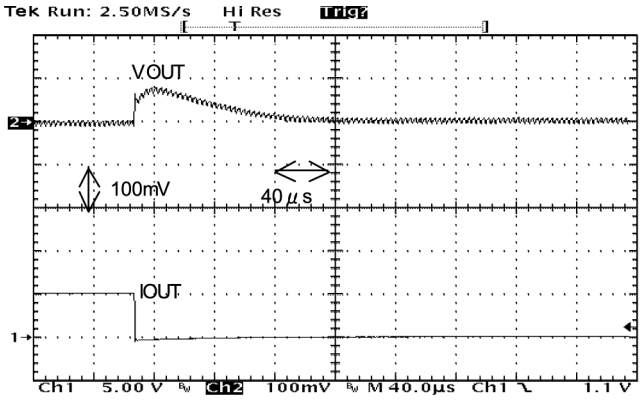
(18) Load Transient Response Characteristics <MODE: High> (Continued)

<Condition>
VIN: 5V
VOUT: 3.3V
IOUT:0A⇔ 1A

MODE: High
FET:SUD30N03 (Vishay)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L:CDRH127/LD-7R4 (SUMIDA)

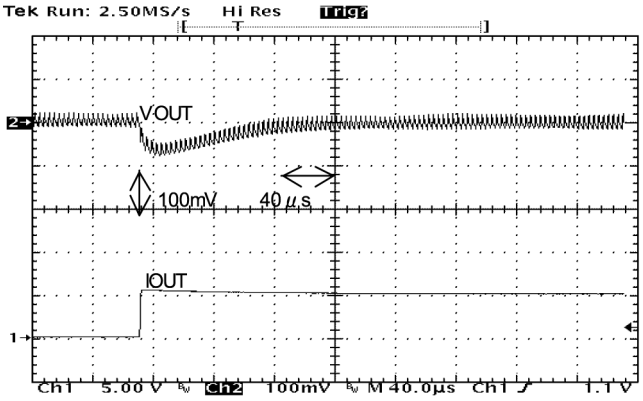


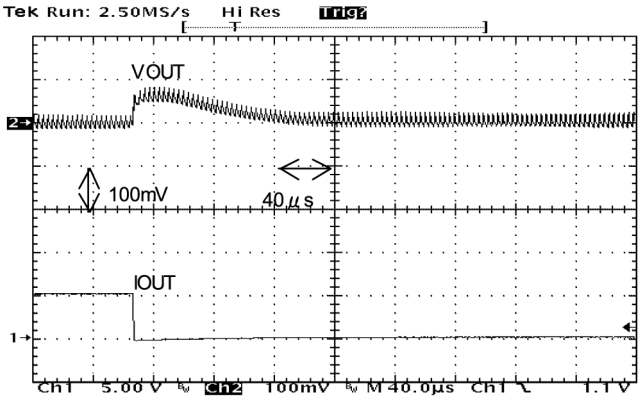


<Condition>
VIN: 15V
VOUT: 3.3V
IOUT:0A⇔ 1A

MODE: High
FET: SUD30N03 (Vishay)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)





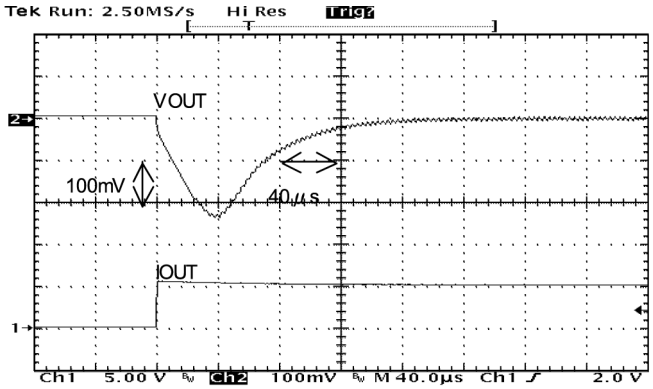
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

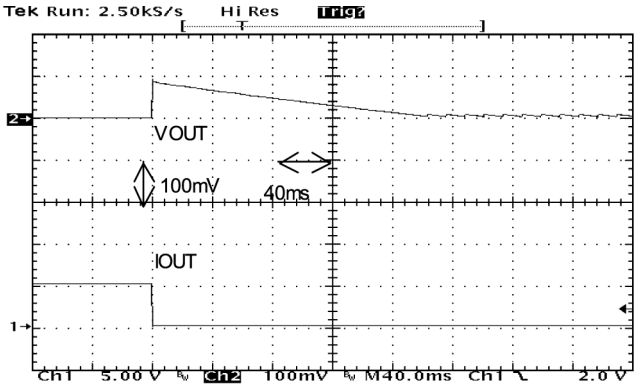
(19) Load Transient Response Characteristics <MODE: Low>

<Condition>
VIN: 5V
VOUT: 1.8V
IOUT:0A⇔ 1A

MODE: Low
FET:IRF7313 (International Rectifier)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)

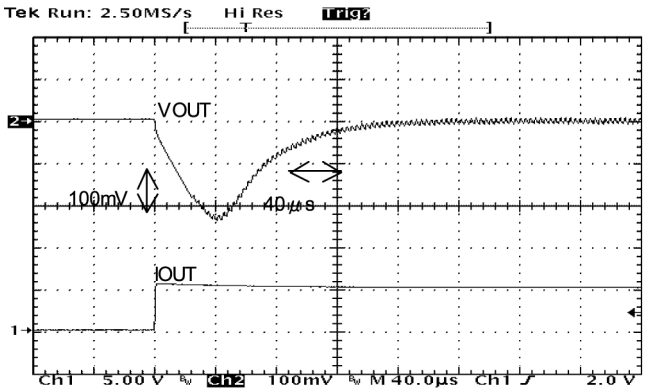


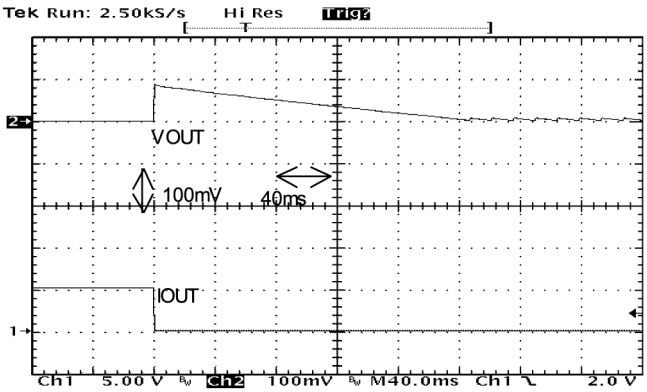


<Condition>
VIN: 5V
VOUT: 1.8V
IOUT:0A⇔ 1A

MODE: Low
FET: SUD30N03 (Vishay)
RSENSE:33mΩ

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)





■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

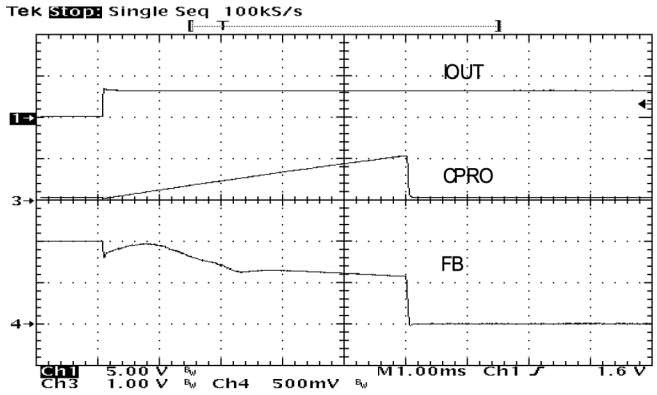
(20) Latch Protection Circuit Operating Waveform <MODE: High>

<Condition>
VIN: 5V
VOUT: 3.3V
MODE: High

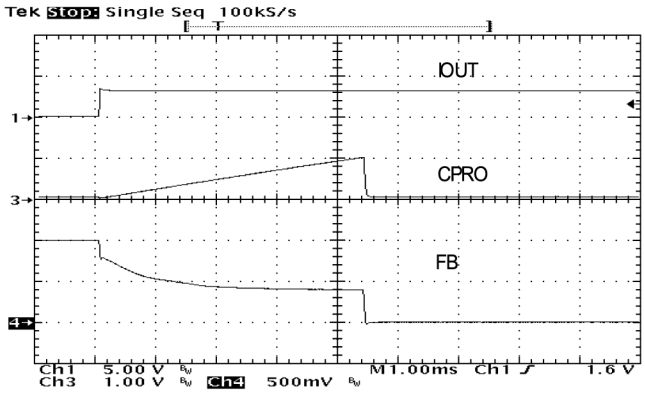
FET: SUD30N03 (Vishay)
RSENSE:33mΩ
CPRO: ceramic 4700pF

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)

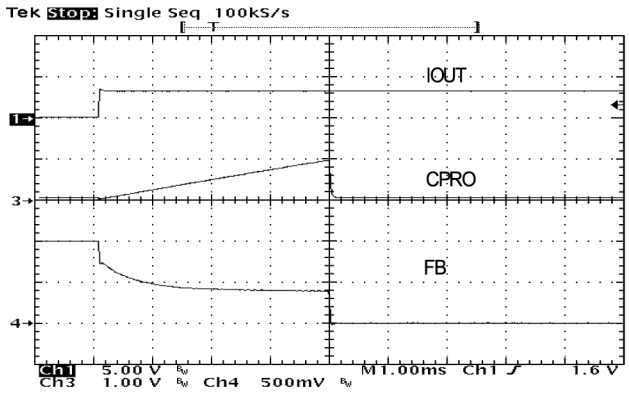
Topr : - 40℃



Topr : 25℃



Topr : 85℃



■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

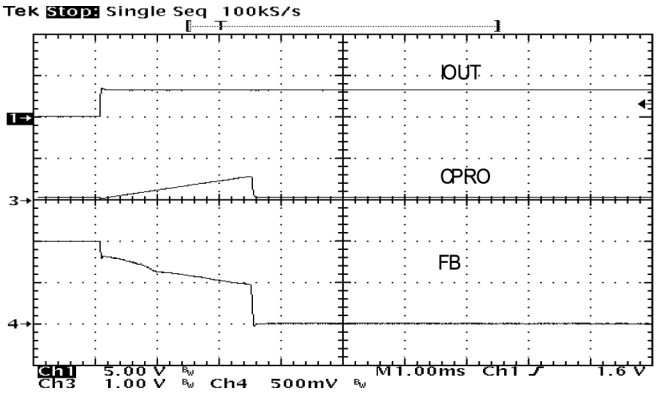
(21) Short-circuit Protection Circuit Operation Waveform

<Condition>
VIN: 5V
VOUT: 3.3V
MODE: High

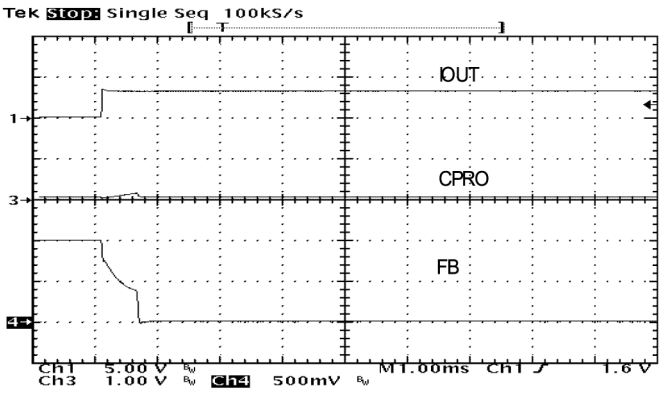
FET: SUD30N03 (Vishay)
RSENSE:33mΩ
CPRO: ceramic 4700pF

CL:150μF (OS-CON, SANYO)
L: CDRH127/LD-7R4 (SUMIDA)

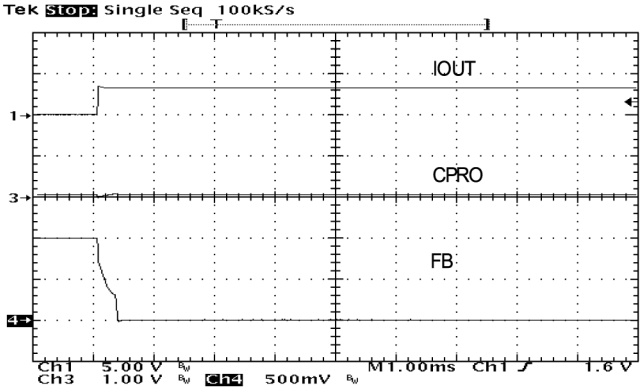
Topr : - 40℃



Topr : 25℃



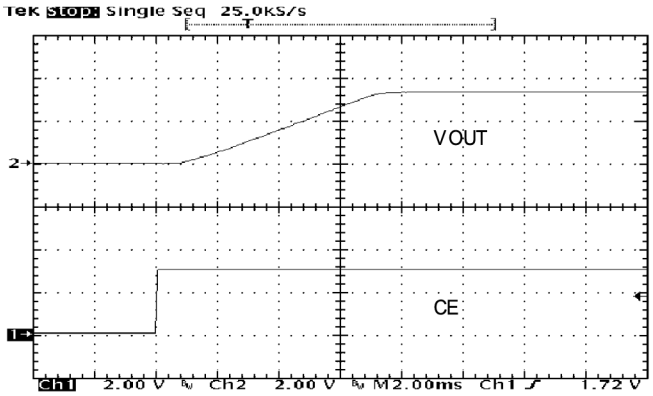
Topr : 85℃

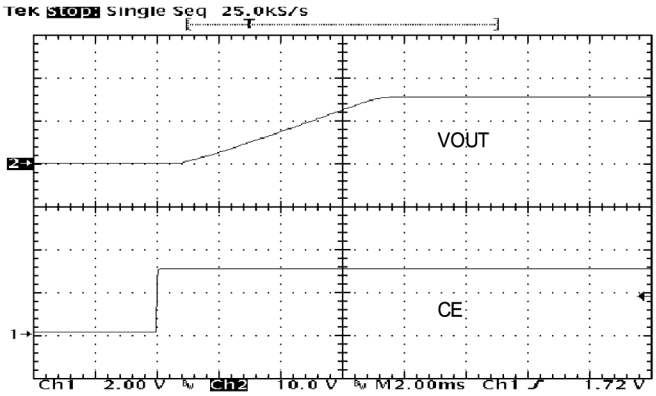


(22) Soft-start Circuit Operation Waveform

<Condition>
VIN: 5V
VOUT: 3.3V
IOUT=100mA

MODE: High
Css: 4700pF



<Condition>
VIN: 20V
VOUT: 15V
IOUT=100mA

MODE: High
Css: 4700pF